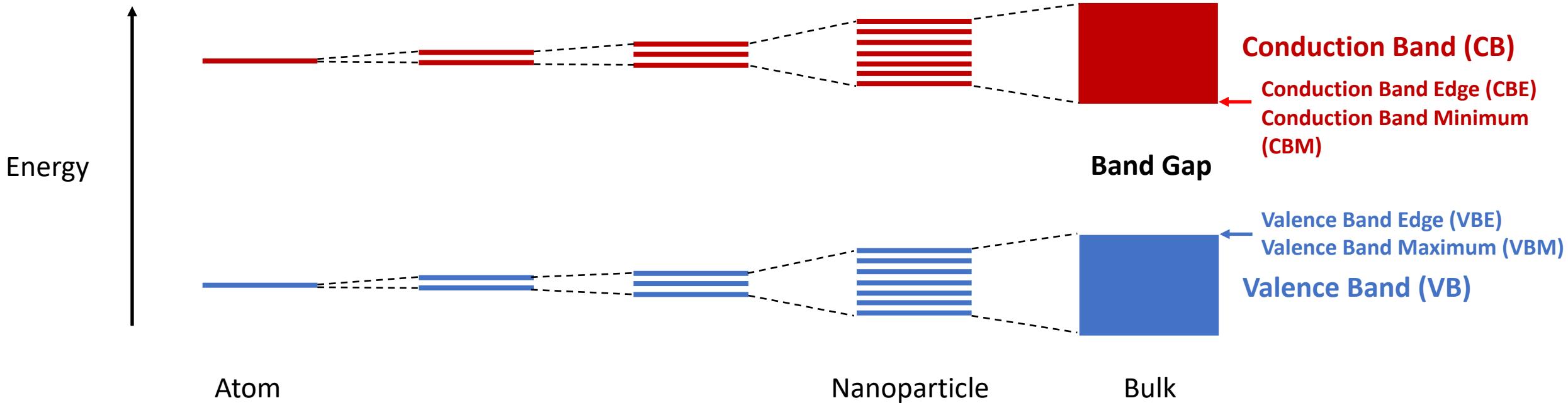


Energy Conversion by Semiconductor Devices

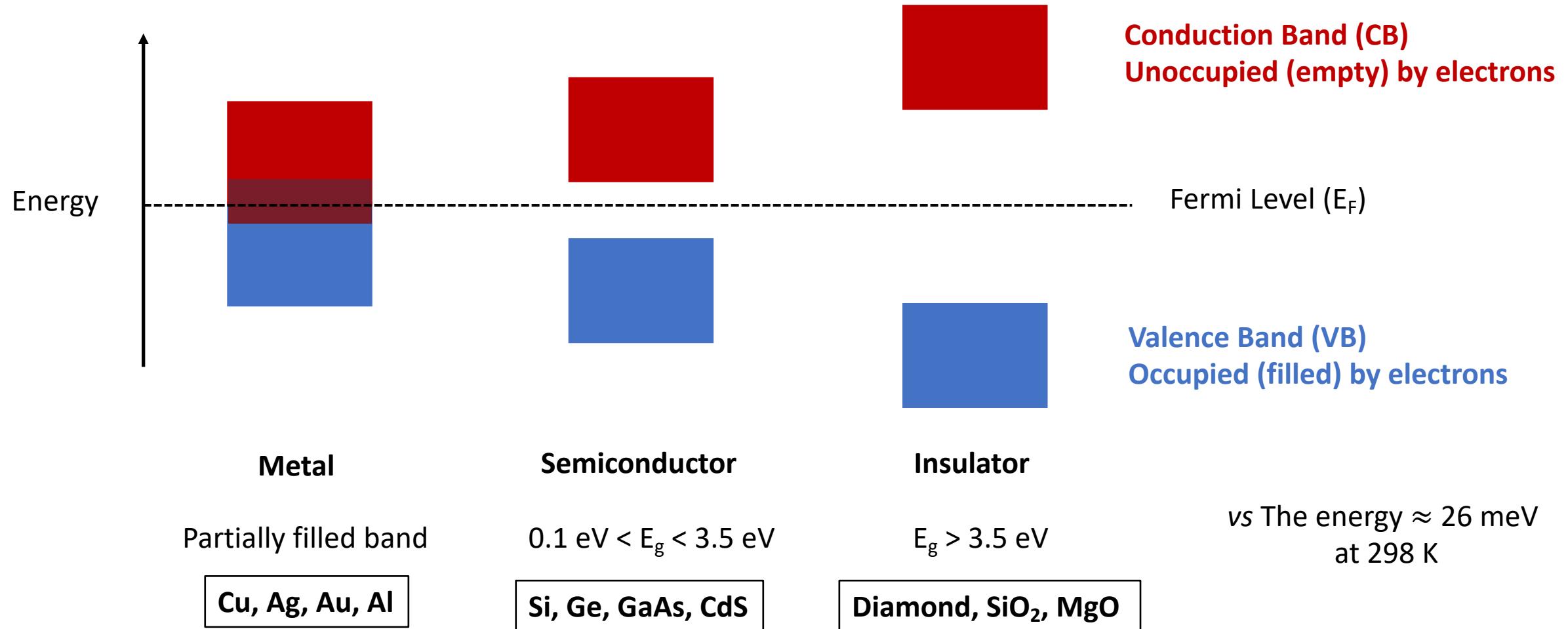
Jun-Ho YUM

junho.yum@epfl.ch

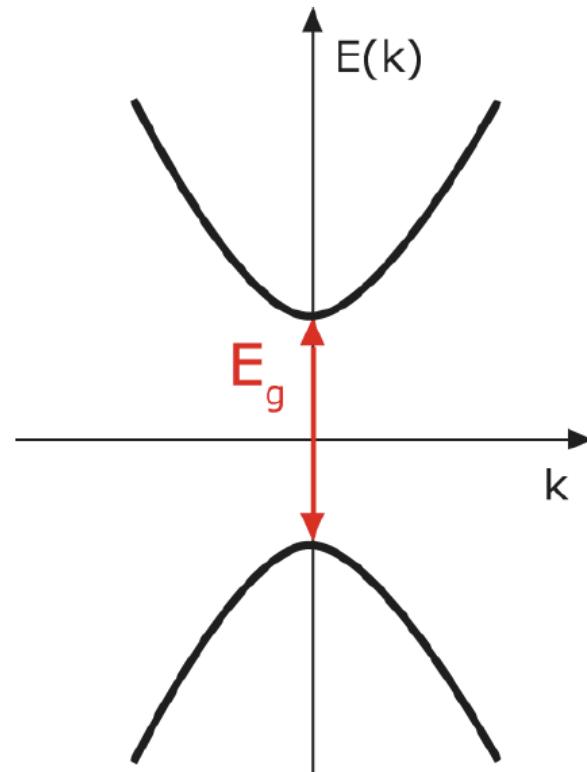


A **band gap** is the distance between the VB and the CB and the band gap represents the minimum energy that is required to excite an electron up to a state in the CB where it can participate in conduction.

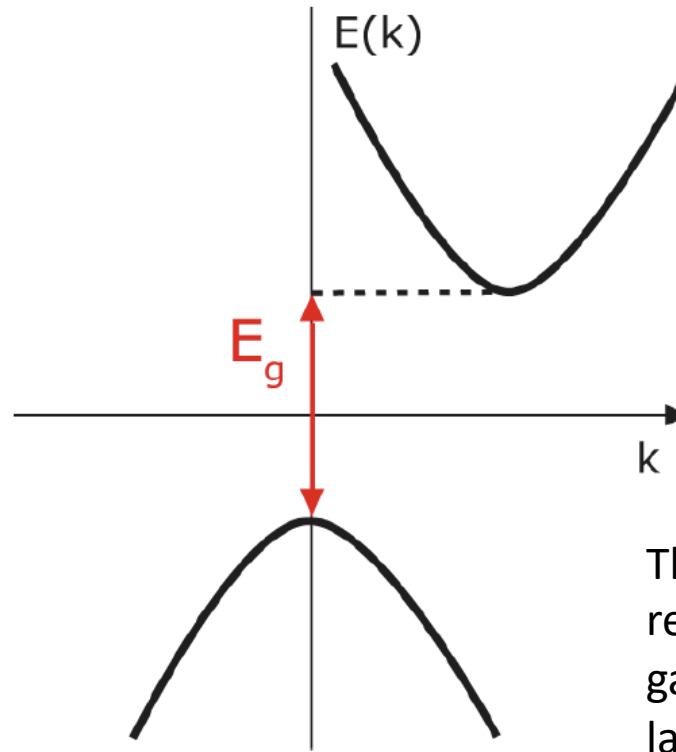
It represents a set of forbidden energies that do not correspond to any allowed combinations of atomic orbitals.



Electron can make a smallest energy transition from the CB to the VB without a change in crystal momentum k value.



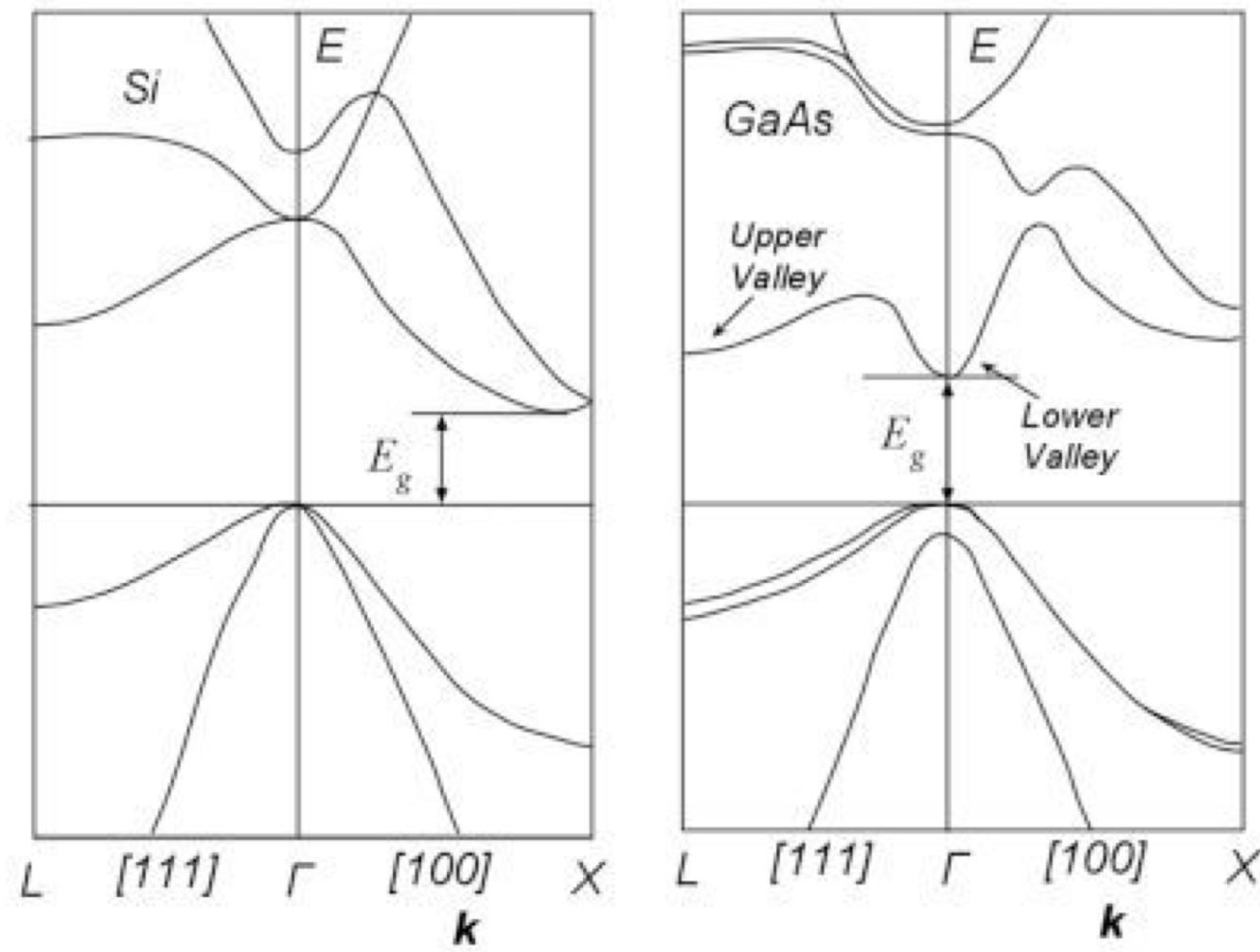
GaAs, CdS, ZnS,
InSb, HgTe, GaN



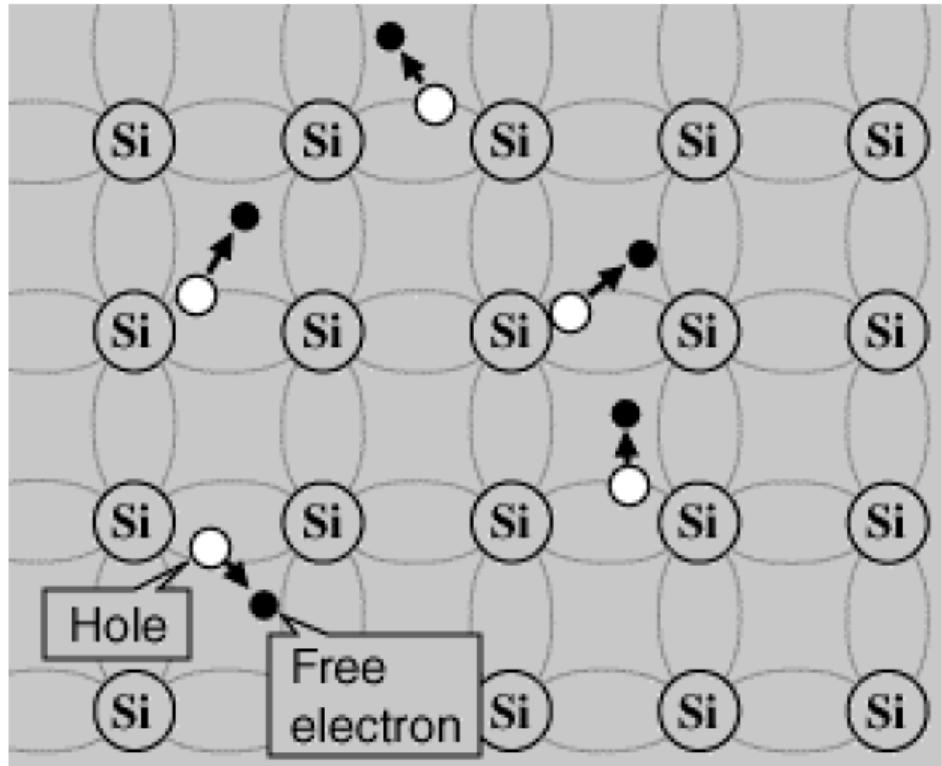
Si, Ge, GaP, AlAs

The change of k value will result from either losing or gaining energy from the lattice vibration (phonons).

EPFL E-k diagram of Si and GaAs

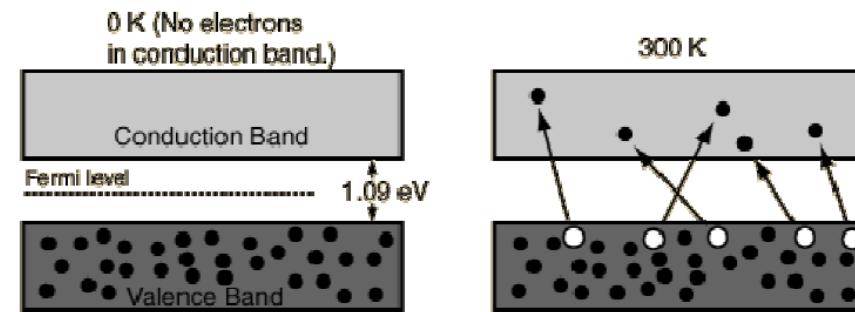


EPFL Charge Carrier Concentration

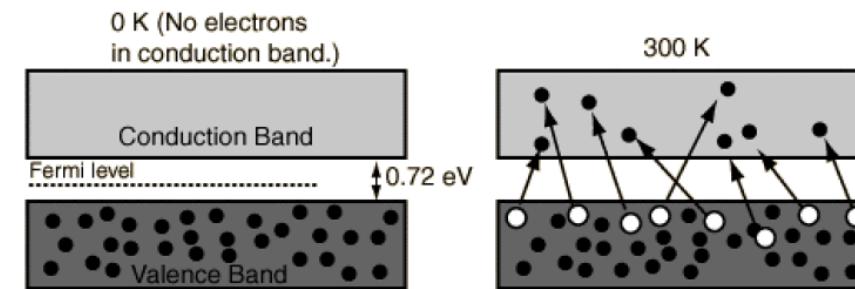


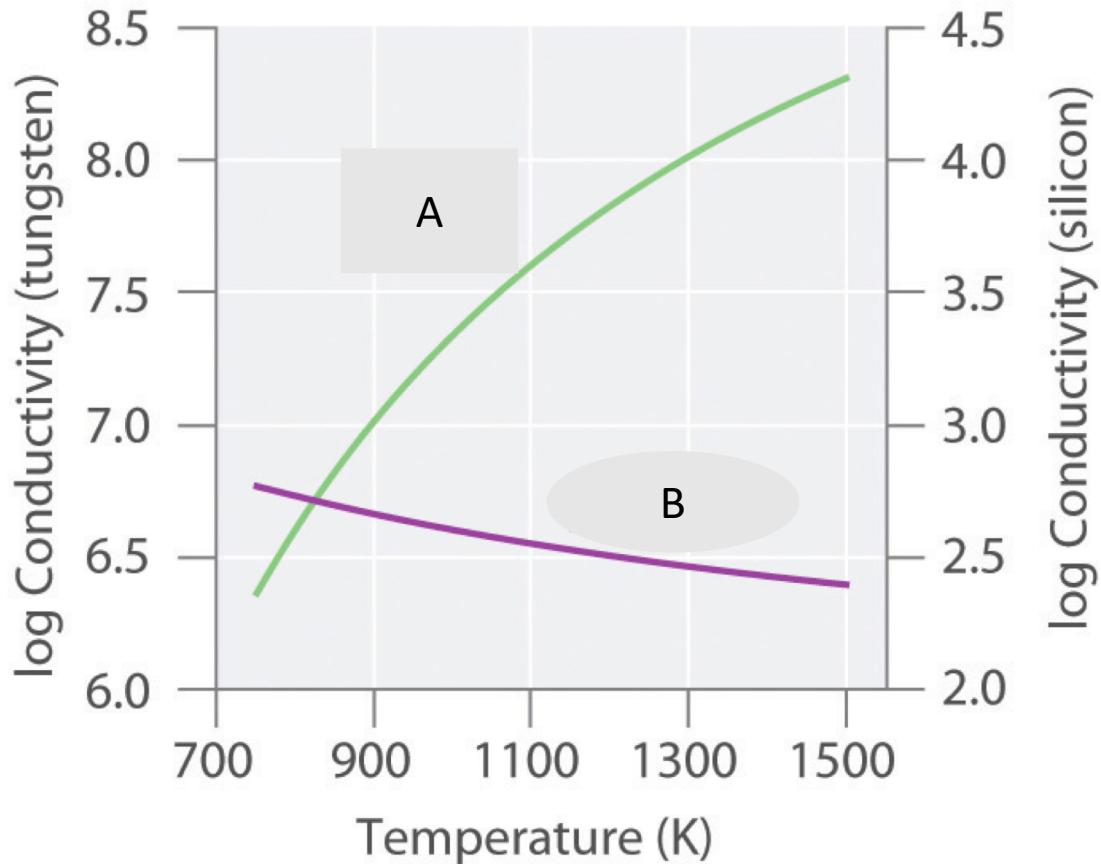
At RT

silicon: $E_g = 1.09 \text{ eV}$



germanium: $E_g = 0.72 \text{ eV}$





$$\sigma = qn\mu_n$$

Which one of A and B is silicon?

Semiconductor has a negative temperature coefficient: The electrical conductivity of a semiconductor increases with increasing temperature.

Metal has a positive temperature coefficient: The electrical conductivity of a metal decreases with increasing temperature.

At higher temperatures, the metal nuclei collide with the mobile electrons more frequently and with greater energy, thus decreasing the conductivity.

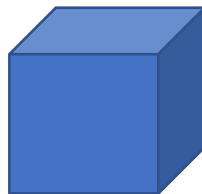
This effect is, however, substantially smaller than the increase in conductivity with temperature exhibited by semiconductors.

- **Charge carrier number = number of states multiplied by % of states occupied by electrons at a given energy.**
- **The density of states** in a semiconductor equals the number of electron states per unit volume per unit energy: energy of the number of solutions to Schrödinger's equation.
- **The Fermi-Dirac distribution** gives the number of electrons, or other fermions, per single-particle state for a macroscopic system at a nonzero temperature.

Q. How many charge carriers?

$$\int g(E) \cdot f(E) dE$$

3D (bulk)



$$g(E) = \frac{(2m)^{3/2} \sqrt{E - E_{min}}}{2\pi^2 \hbar^3}$$

2D (slab)



$$g(E) = \frac{m}{\pi \hbar^2}$$

1D (wire)



$$g(E) = \frac{1}{\hbar \pi} \cdot \sqrt{\frac{m}{2E - E_{min}}}$$

0D (dot)

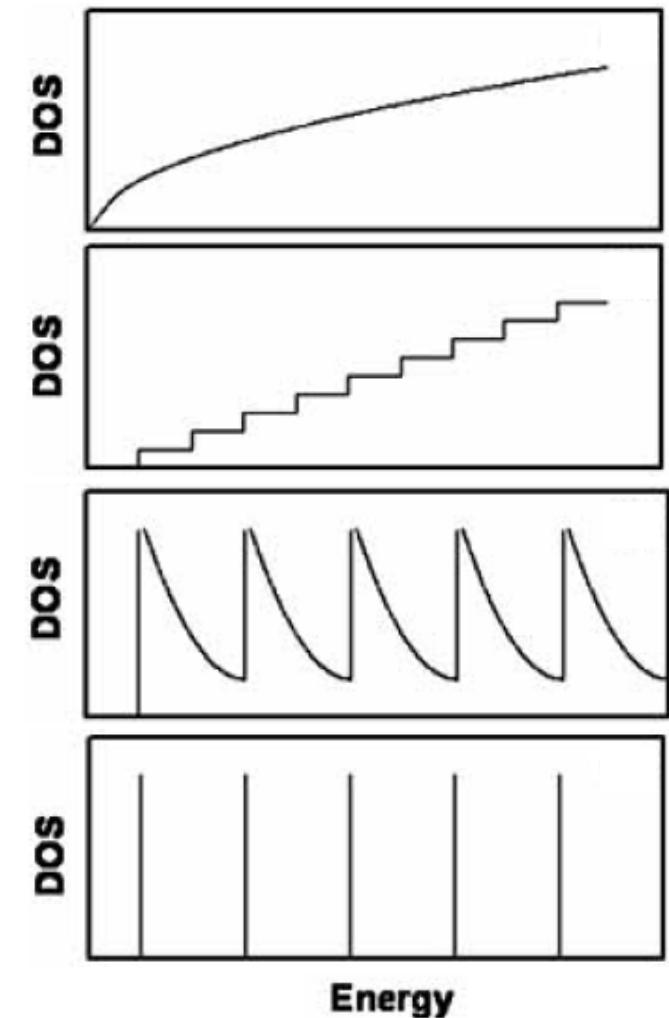


$$g(E) = 2\delta(E - E_{min})$$

$$\hbar = \frac{h}{2\pi}, \text{ reduced planck constant}$$

$g(E)$ = Density of States

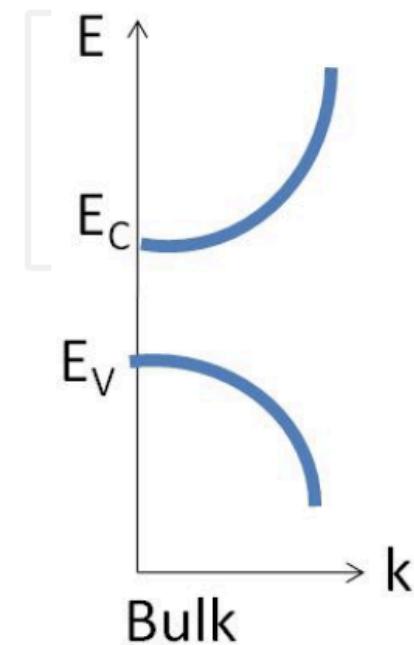
$f(E)$ = Probability of occupied states



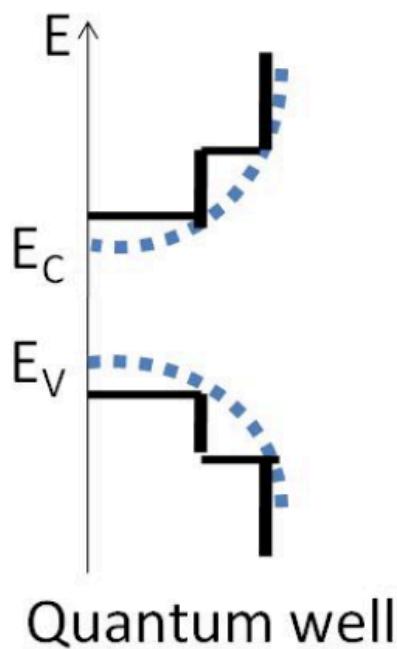
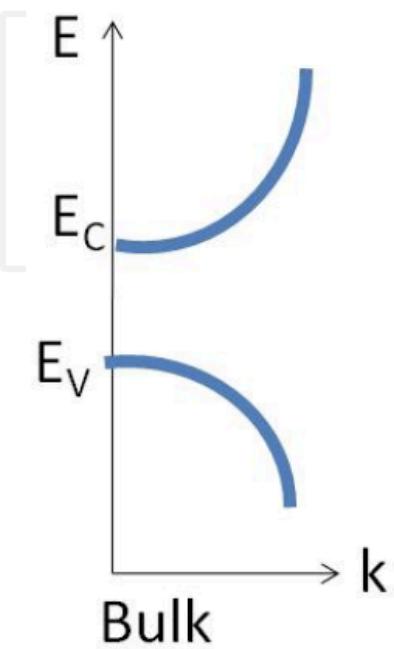
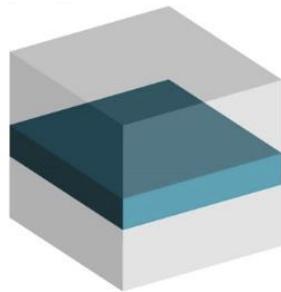
Dimensionality of a material specifies how many dimensions do the carriers of the material act as free carriers.



- In bulk semiconductor, continuous density of states results in both conduction and valence bands

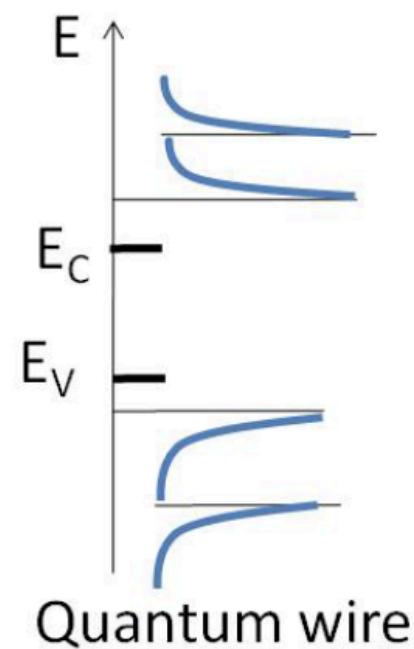
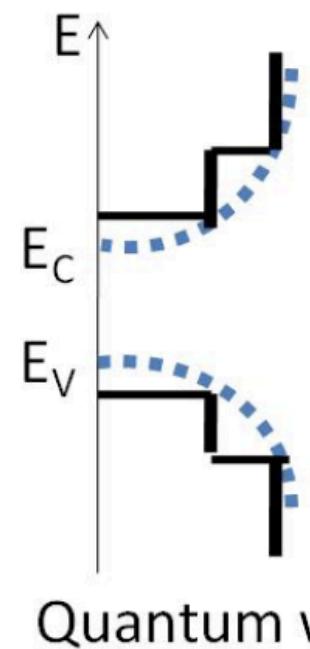
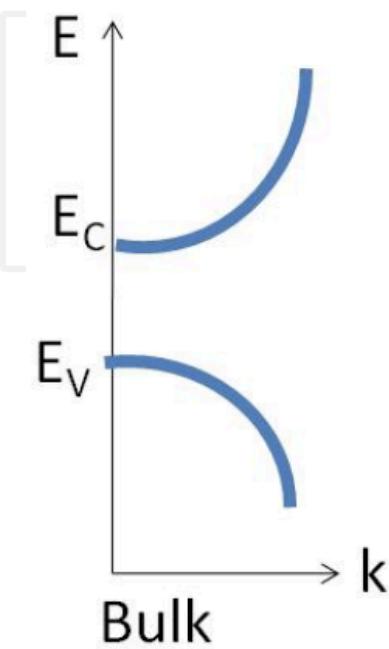
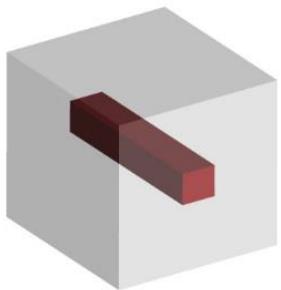
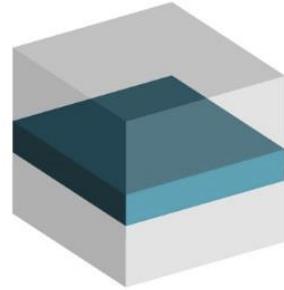
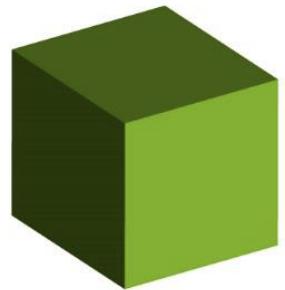


Dimensionality of a material specifies how many dimensions do the carriers of the material act as free carriers.



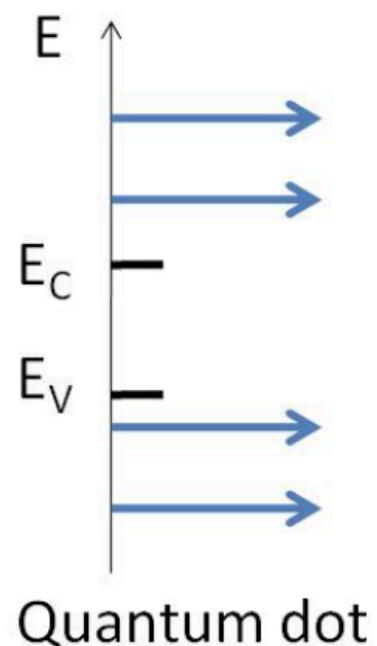
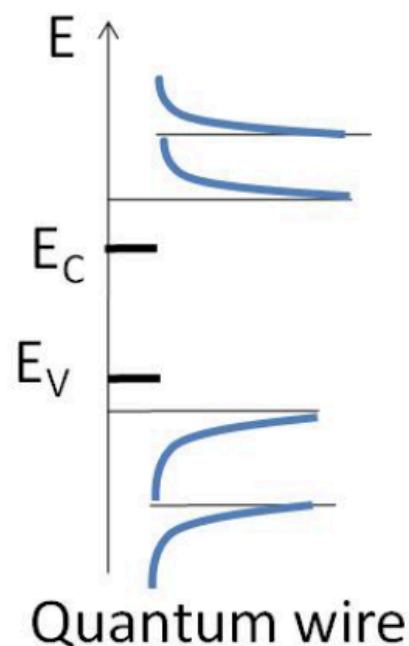
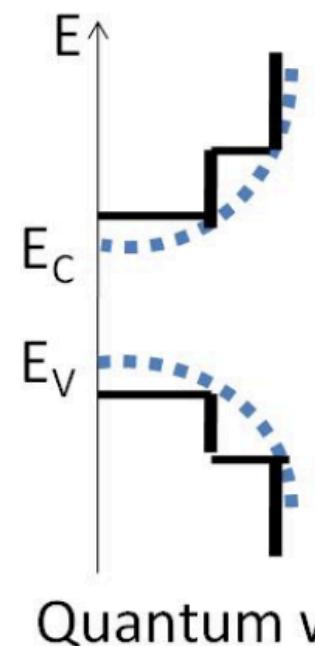
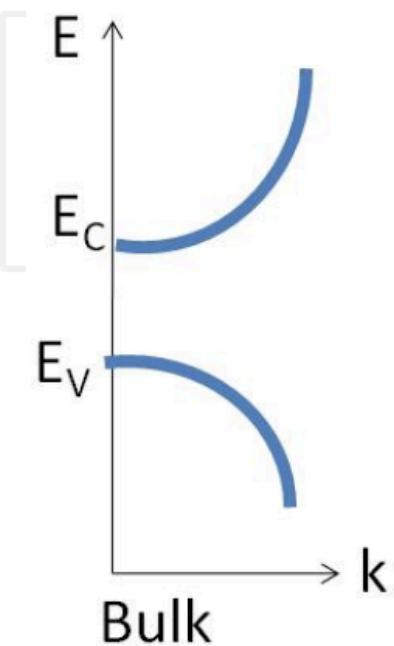
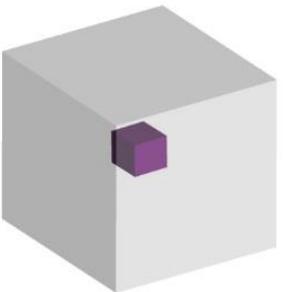
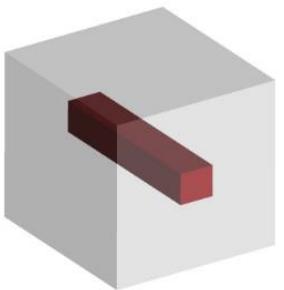
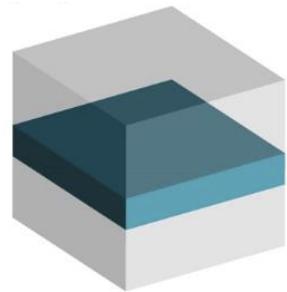
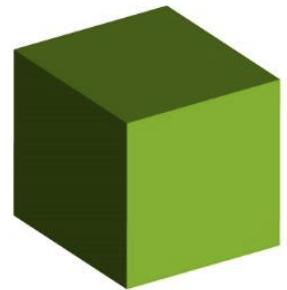
- In bulk semiconductor, continuous density of states results in both conduction and valence bands.
- A **two dimensional system where electrons are confined in one dimension and therefore possess stepwise density of states.**

Dimensionality of a material specifies how many dimensions do the carriers of the material act as free carriers.



- In bulk semiconductor, continuous density of states results in both conduction and valence bands.
- A two dimensional system where electrons are confined in one dimension and therefore possess step like density of states.
- **Quantum wire system** is a **one dimensional system where electrons are confined in two dimensions**.

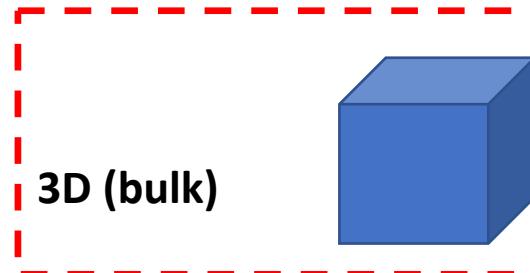
Dimensionality of a material specifies how many dimensions do the carriers of the material act as free carriers.



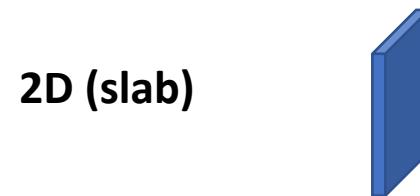
- In bulk semiconductor, continuous density of states results in both conduction and valence bands.
- A two dimensional system where electrons are confined in one dimension and therefore possess step like density of states.
- Quantum wire system is a one dimensional system where electrons are confined in two dimensions.
- Quantum dot is a zero dimensional system where electron motion is confined in three dimensions. Therefore, a quantum dot possess atomic like DOS.

Q. How many charge carriers?

$$\int g(E) \cdot f(E) dE$$



$$g(E) = \frac{(2m)^{3/2} \sqrt{E - E_{min}}}{2\pi^2 \hbar^3}$$



$$g(E) = \frac{m}{\pi \hbar^2}$$



$$g(E) = \frac{1}{\hbar \pi} \cdot \sqrt{\frac{m}{2E - E_{min}}}$$

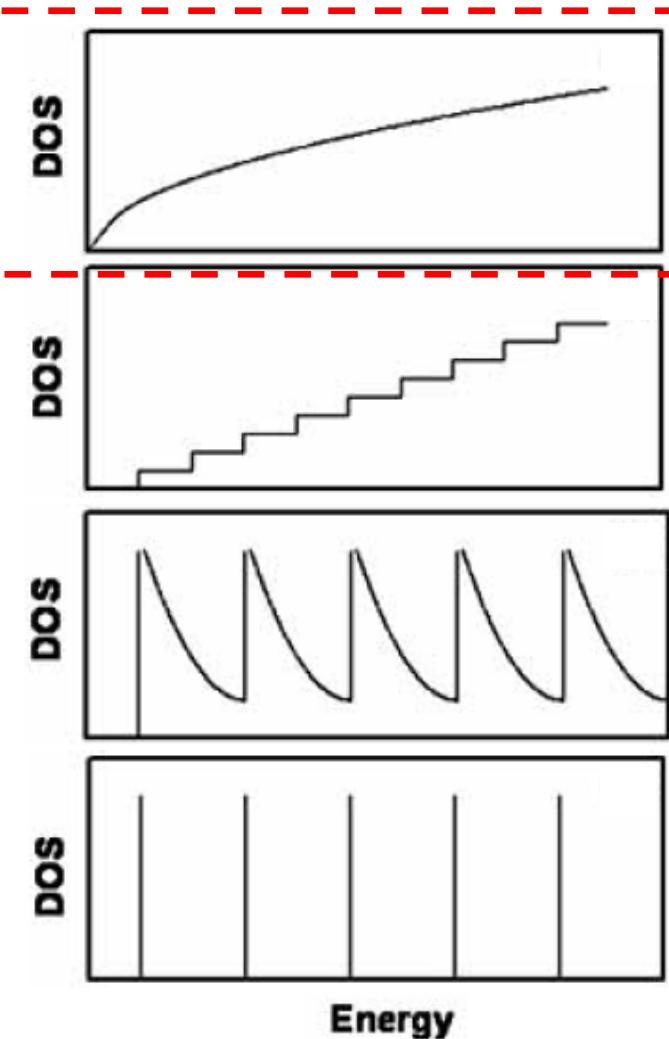


$$g(E) = 2\delta(E - E_{min})$$

$$\hbar = \frac{h}{2\pi}, \text{ reduced planck constant}$$

$g(E)$ = Density of States

$f(E)$ = Probability of occupied states



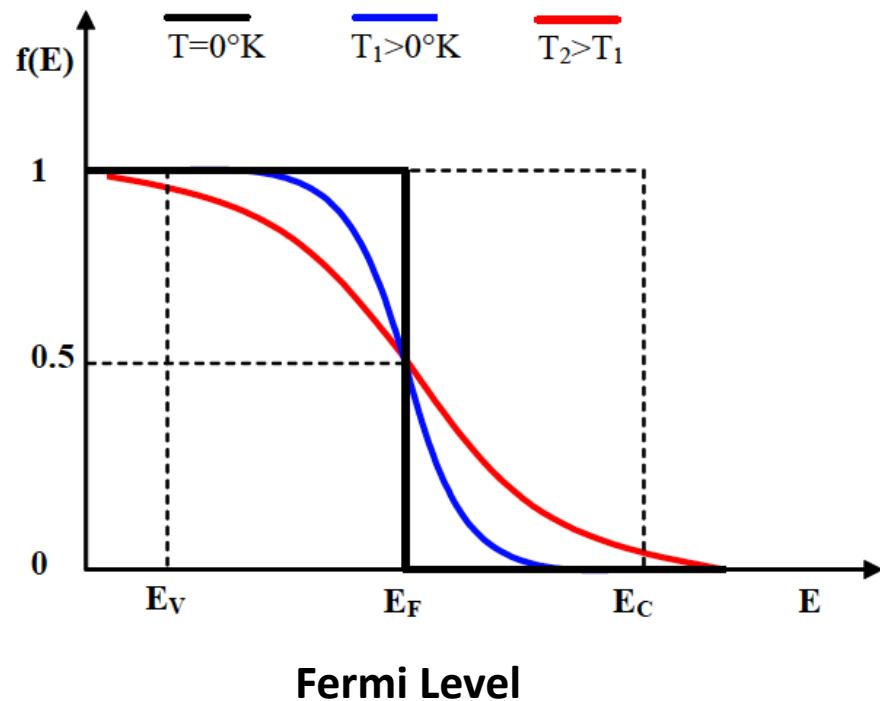
Q. How many charge carriers?

$$\int g(E) \cdot f(E) dE$$

$g(E)$ = Density of States

$f(E)$ = Probability of occupied states

$$f(E) = \frac{1}{1 + \exp(\frac{E - E_F}{k_B T})} \quad 0 \leq f(E) \leq 1$$

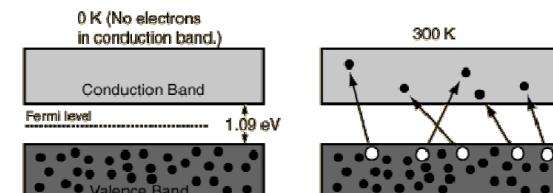


At $T = 0 \text{ K}$

$$E > E_F: \frac{1}{1 + \exp(+\infty)} = 0$$

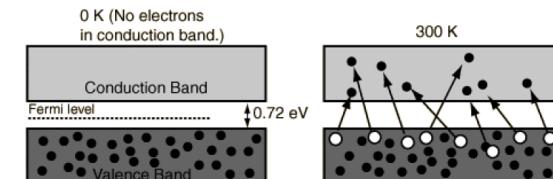
$$E < E_F: \frac{1}{1 + \exp(-\infty)} = 1$$

Probability to find electrons above E_F increases as temperature increases.



silicon: $E_g = 1.09 \text{ eV}$

germanium: $E_g = 0.72 \text{ eV}$



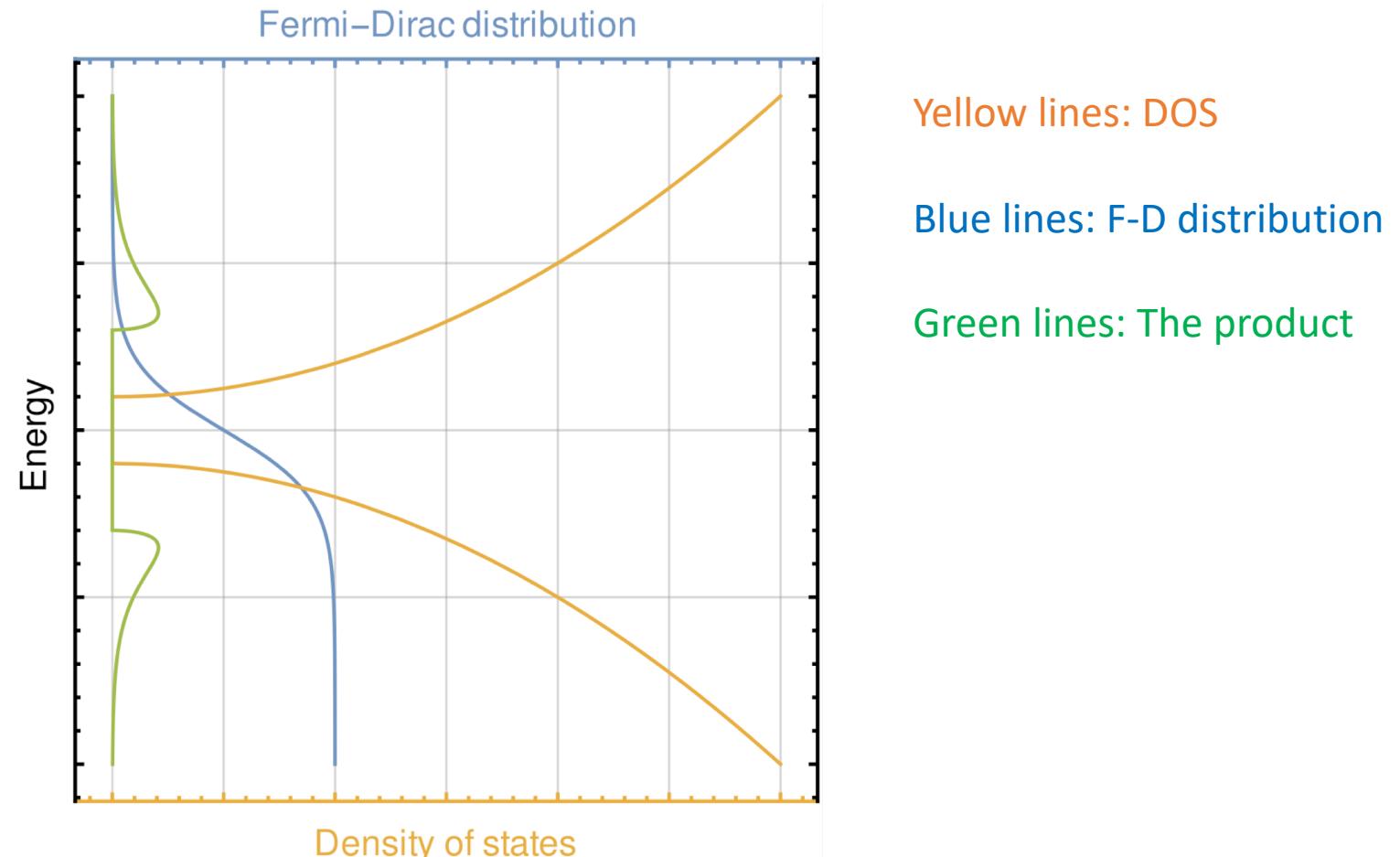
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$$\int g(E) \cdot f(E) dE$$

$g(E)$ = *Density of States*
 $f(E)$ = *Probability of occupied states*

$$n = \int_{E_c}^{E_{top}} g_c(E) \cdot f(E) dE$$

$$p = \int_{E_{bottom}}^{E_v} g_v(E) \cdot [1 - f(E)] dE$$



AM	Comments	Solar constant (W/cm ²)	$h\nu_{av}$	N_{ph} (cm ⁻² sec ⁻¹)
0	Outside atmosphere	1367	1.48 eV (838 nm)	5.8×10^{17}
1	Sea level, sun at zenith	1040	1.32 eV (939 nm) Red shift	5.0×10^{17}
2	Sea level, sun at 60 degree from zenith	840	1.28 eV (969 nm) Red shift	4.3×10^{17}
3	Sea level, sun at 70.5 degree from zenith	750	1.21 eV (1025 nm) Red shift	3.9×10^{17}
1	Cloudy weather	120	1.44 eV (861 nm) Blue shift	5.2×10^{16}

$$AM \approx 1/\cos(z)$$

This is reasonably accurate for value of z up to around 75 degree.

$$AM = \sqrt{(r\cos(z))^2 + 2r + 1} - r\cos(z)$$

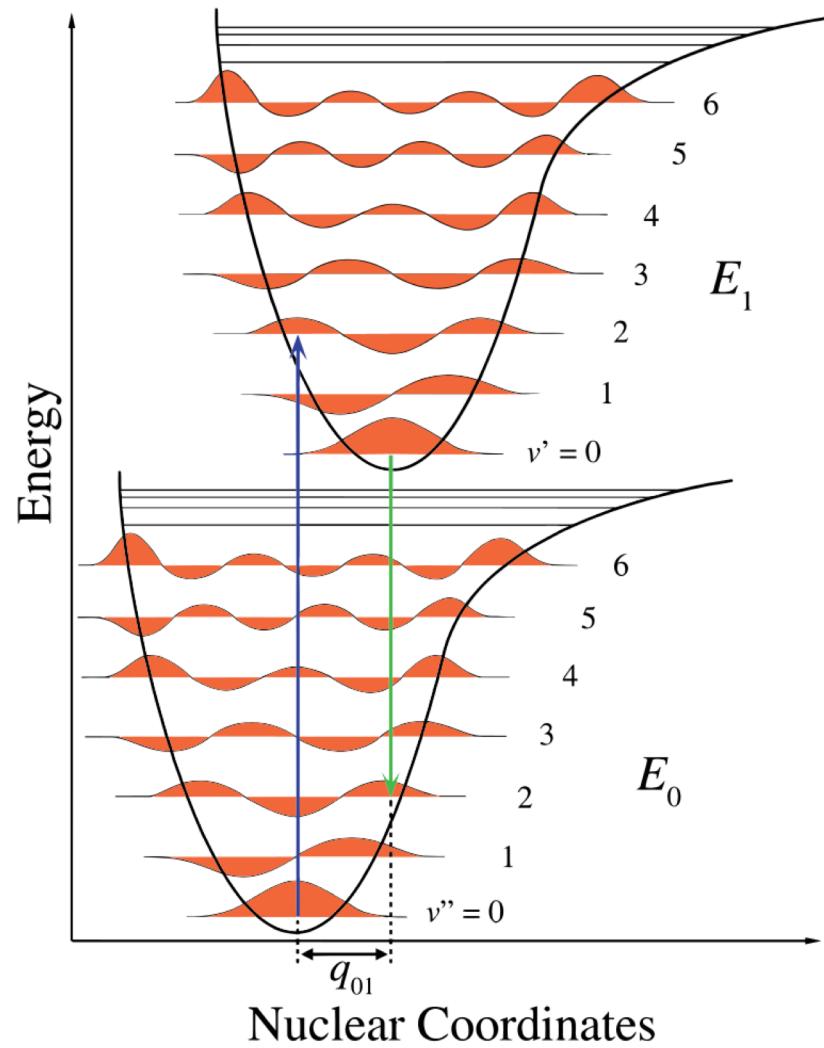
Modelling the atmosphere as a simple spherical shell provides a reasonable approximation⁽¹⁾

(1) Schoenberg, E. Theoretische Photometrie, g) Über die Extinktion des Lichtes in der Erdatmosphäre. In *Handbuch der Astrophysik*. Band II, erste Hälfte. Berlin: Springer (1929).

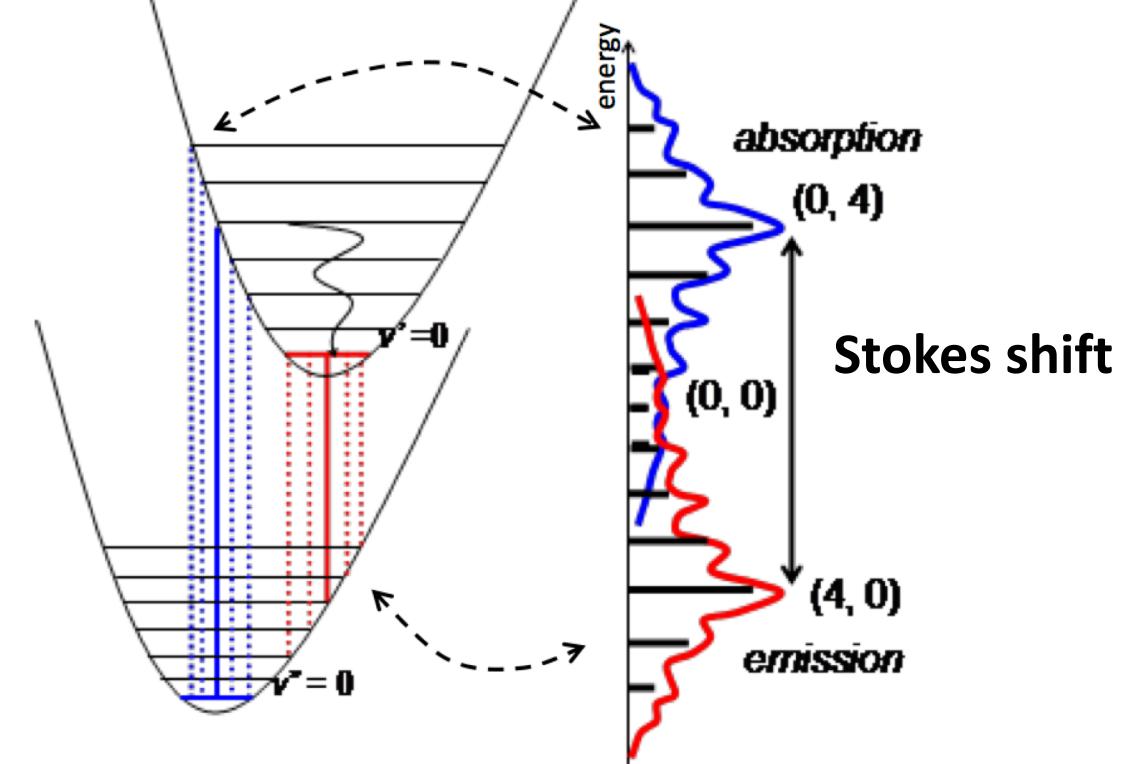
r = the radius of the Earth/the effective height of the atmosphere = 6371/9

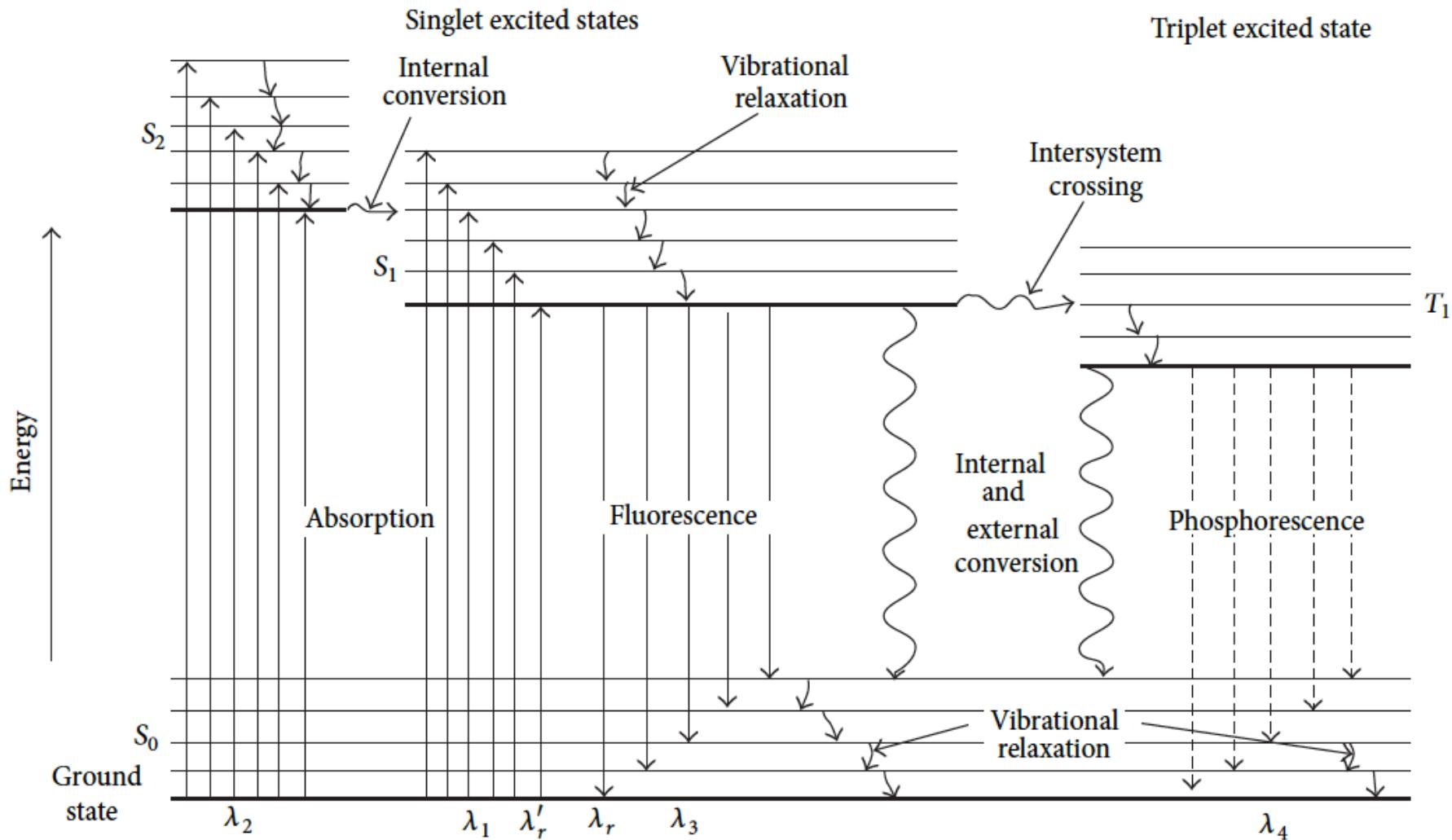
z (degree)	Flat Earth	Spherical shell	Global irradiance (W/m²)
0	1.0	1.0	1367
48.2	1.5		
60	2.0	2.0	840
70	2.9	2.9	710
75	3.9	3.8	620
80	5.8	5.6	470
85	11.5	10.6	254
88	28.7	20.3	96
90	∞	37.6	20

Franck-Condon Principle



Mirror image spectra





Jablonski diagram

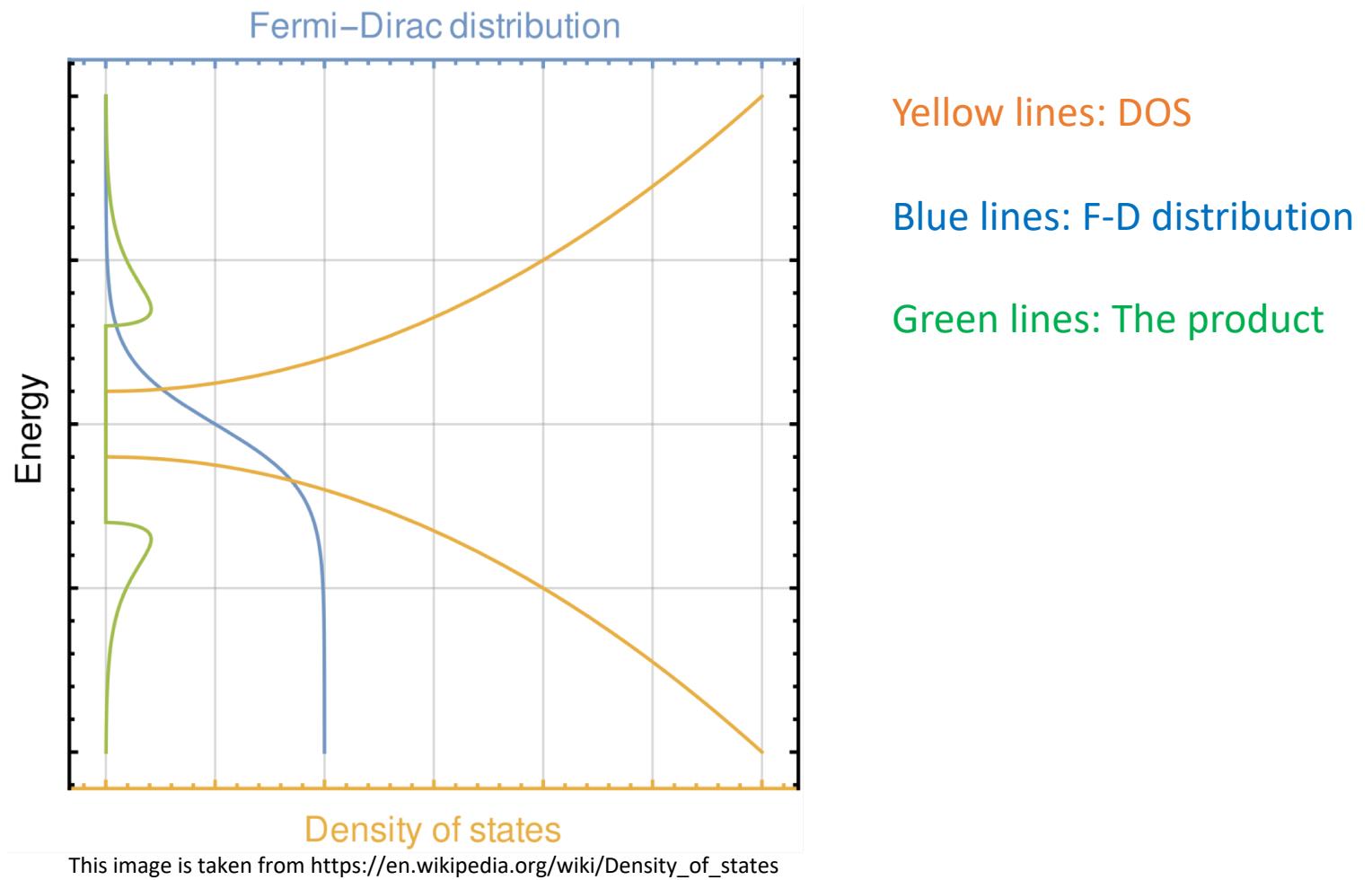
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$g(E) = \text{Density of States}$
 $f(E) = \text{Probability of occupied states}$

$$n = \int_{E_c}^{E_{top}} g_c(E) \cdot f(E) dE$$

$$p = \int_{E_{bottom}}^{E_v} g_v(E) \cdot [1 - f(E)] dE$$



Q. How many charge carriers?

$$\int g(E) \cdot f(E) dE$$

$g(E)$ = Density of States

$f(E)$ = Probability of occupied states

$$n = \int_{E_c}^{\infty} g_c(E) \cdot f(E) dE$$

$$g_c(E) = \frac{8\pi\sqrt{2}m^{3/2}\sqrt{E - E_c}dE}{h^3}$$

Boltzmann approximation

$$f(E) = \frac{1}{1 + \exp(\frac{E - E_F}{k_B T})}$$

$$f(E) = \exp\left[\frac{-(E - E_F)}{k_B T}\right] \quad \text{if } E - E_F > 3k_B T$$

m^* is the effective mass

$$n = 2 \left(\frac{2\pi m_e^* k_B T}{h^2} \right)^{\frac{3}{2}} \cdot \exp\left[\frac{(E_F - E_c)}{k_B T}\right] = N_c \exp\left[\frac{(E_F - E_c)}{k_B T}\right]$$

N_c is the effective density of states in CB.

$$p \cong \int_{-\infty}^{E_V} \frac{8\pi\sqrt{2}m^{\frac{3}{2}}\sqrt{E_V - E}}{h^3} \cdot \exp\left[\frac{(E - E_F)}{k_B T}\right] dE = 2 \left(\frac{2\pi m_h^* k_B T}{h^2} \right)^{\frac{3}{2}} \cdot \exp\left[\frac{(E_V - E_F)}{k_B T}\right] = N_V \exp\left[\frac{(E_V - E_F)}{k_B T}\right]$$

N_V is the effective density of states in VB.

$$N_C = 2 \left(\frac{2\pi m_e^* k_B T}{h^2} \right)^{\frac{3}{2}} = 2 \left(\frac{2\pi \times 1.08 \times 9.11 \times 10^{-31} \text{kg} \times 1.38 \times 10^{-23} \text{m}^2 \text{kgs}^{-2} \text{K}^{-1} \times 300 \text{K}}{(6.626 \times 10^{-34} \text{m}^2 \text{kgs}^{-1})^2} \right)^{\frac{3}{2}} = 2.81 \times 10^{25} \text{ m}^{-3}$$

$$= 2.81 \times 10^{19} \text{ cm}^{-3}$$

$$N_V = 2 \left(\frac{2\pi m_h^* k_B T}{h^2} \right)^{\frac{3}{2}} = 1.83 \times 10^{19} \text{ cm}^{-3} \quad \text{with } m_h^* = 0.81 \times 9.11 \times 10^{-31} \text{kg}$$

In an intrinsic semiconductor in the equilibrium $n = p = n_i$ (Mass action law)

$$np = n_i^2 = N_C \exp \left[\frac{(E_F - E_C)}{k_B T} \right] \times N_V \exp \left[\frac{(E_V - E_F)}{k_B T} \right] = N_C N_V \exp \left[\frac{(E_V - E_C)}{k_B T} \right] = N_C N_V \exp \left(\frac{-E_g}{k_B T} \right)$$

which is independent of the position of the Fermi level.

$$n_i = 8.87 \times 10^9 \text{ cm}^{-3}$$

With $E_g = 1.12 \text{ eV}$

$$k_B T = 0.0259 \text{ eV}$$

Name	Symbol	Germanium	Silicon	Gallium Arsenide
Energy bandgap at 300 K	E_g (eV)	0.66	1.12	1.424
Effective mass for density of states calculations				
Electrons	$m_e^{*,\text{dos}}/m_0$	0.56	1.08	0.067
Holes	$m_h^{*,\text{dos}}/m_0$	0.29	0.81	0.47
Effective density of states in the conduction band at 300 K	N_c (cm ⁻³)	1.05×10^{19}	2.82×10^{19}	4.35×10^{17}
Effective density of states in the valence band at 300 K	N_v (cm ⁻³)	3.91×10^{18}	1.83×10^{19}	8.07×10^{18}
Intrinsic carrier density at 300 K	n_i (cm ⁻³)	1.83×10^{13}	8.87×10^9	2.05×10^6
Effective density of states in the conduction band at 100 ° C (373.15 K)	N_c (cm ⁻³)	1.46×10^{19}	3.90×10^{19}	6.03×10^{17}
Effective density of states in the valence band at 100 ° C	N_v (cm ⁻³)	5.43×10^{18}	2.53×10^{19}	1.12×10^{19}
Intrinsic carrier density at 100 ° C	n_i (cm ⁻³)	3.11×10^{14}	8.59×10^{11}	6.29×10^8

In an intrinsic semiconductor, $n = p$. Therefore $E_C - E_F \approx E_F - E_V$ and the Fermi level is nearly at the middle of the band gap, i.e., $E_F \approx E_C - E_g/2$.

We use these the equation previously mentioned:

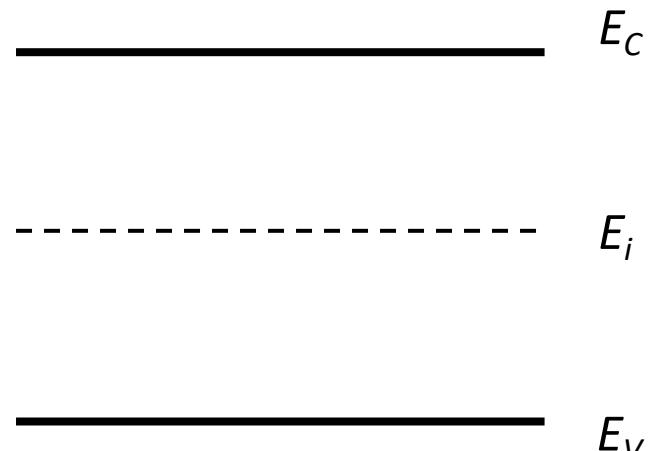
$$np = n_i^2 = N_C \exp \left[\frac{(E_F - E_C)}{k_B T} \right] \times N_V \exp \left[\frac{(E_V - E_F)}{k_B T} \right]$$

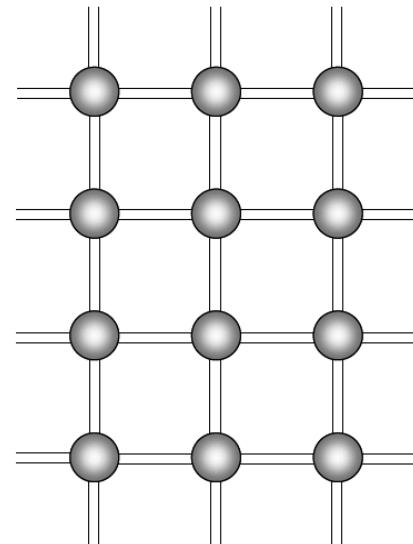
We denote the position of the Fermi level in the intrinsic material E_i .

$$n_i = N_C \exp \left[\frac{(E_i - E_C)}{k_B T} \right] = N_V \exp \left[\frac{(E_V - E_i)}{k_B T} \right]$$

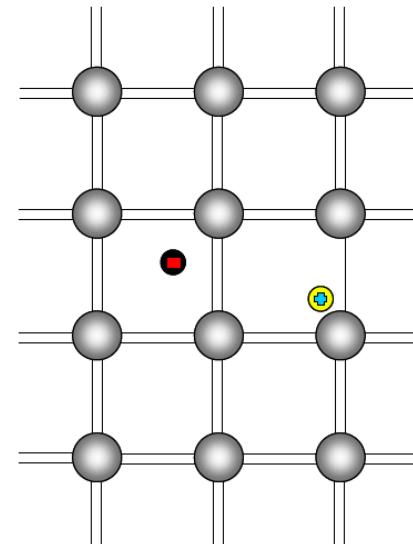
$$E_i = \frac{E_C + E_V}{2} + \frac{k_B T}{2} \ln \left(\frac{N_V}{N_C} \right) = E_C - \frac{E_g}{2} + \frac{k_B T}{2} \ln \left(\frac{N_V}{N_C} \right)$$

A slight shift is caused by the difference in N_C and N_V ,
ex) 0.01 eV for Si





At 0 K



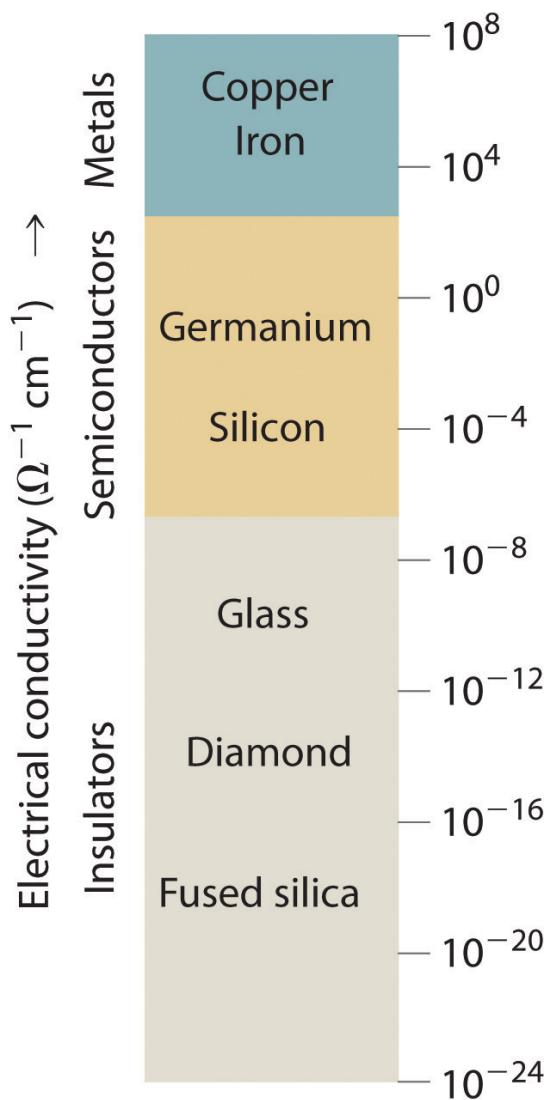
> 0 K

Electrical conductivity of intrinsic Si!

$$\sigma = e(n\mu_e + p\mu_h)$$

Intrinsic carrier concentration: $8.87 \times 10^9 \text{ cm}^{-3}$
Electron mobility = $1000 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$
Hole mobility = $500 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$

$$\sigma = 2.13 \times 10^{-6} \Omega^{-1} \text{cm}^{-1}$$



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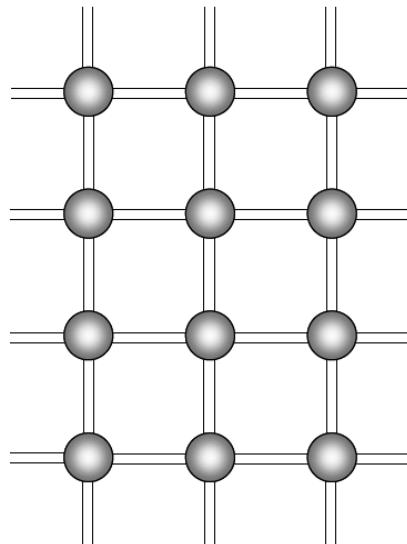
$$\sigma = 2.13 \times 10^{-6} \Omega^{-1} \text{ cm}^{-1}$$

Image taken from

https://chem.libretexts.org/Courses/Northern_Michigan_University/CH_215%3A_Chemistry_of_the_Elements_Fall_2023/05%3A_Solids_and_Solid-State_Chemistry/5.14%3A_Bonding_in_Metals

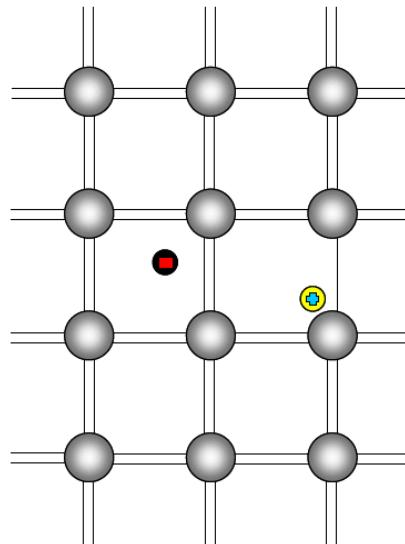
The doping process can greatly alter the electrical characteristics of the semiconductor. This doped semiconductor is called an extrinsic material.

Intrinsic SC



Si atom covalent bond

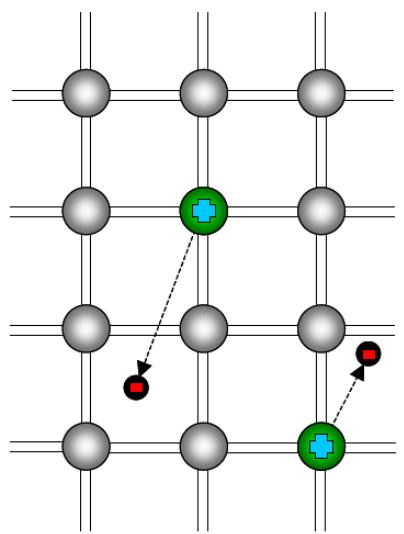
At 0 K



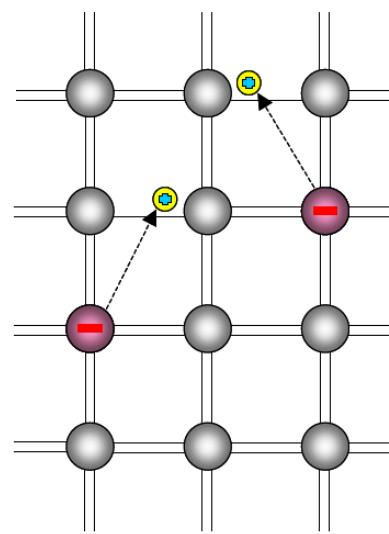
electron hole

> 0 K

Extrinsic SC



ionised P_4^+ atom

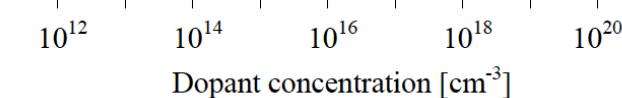


ionised B_4^- atom

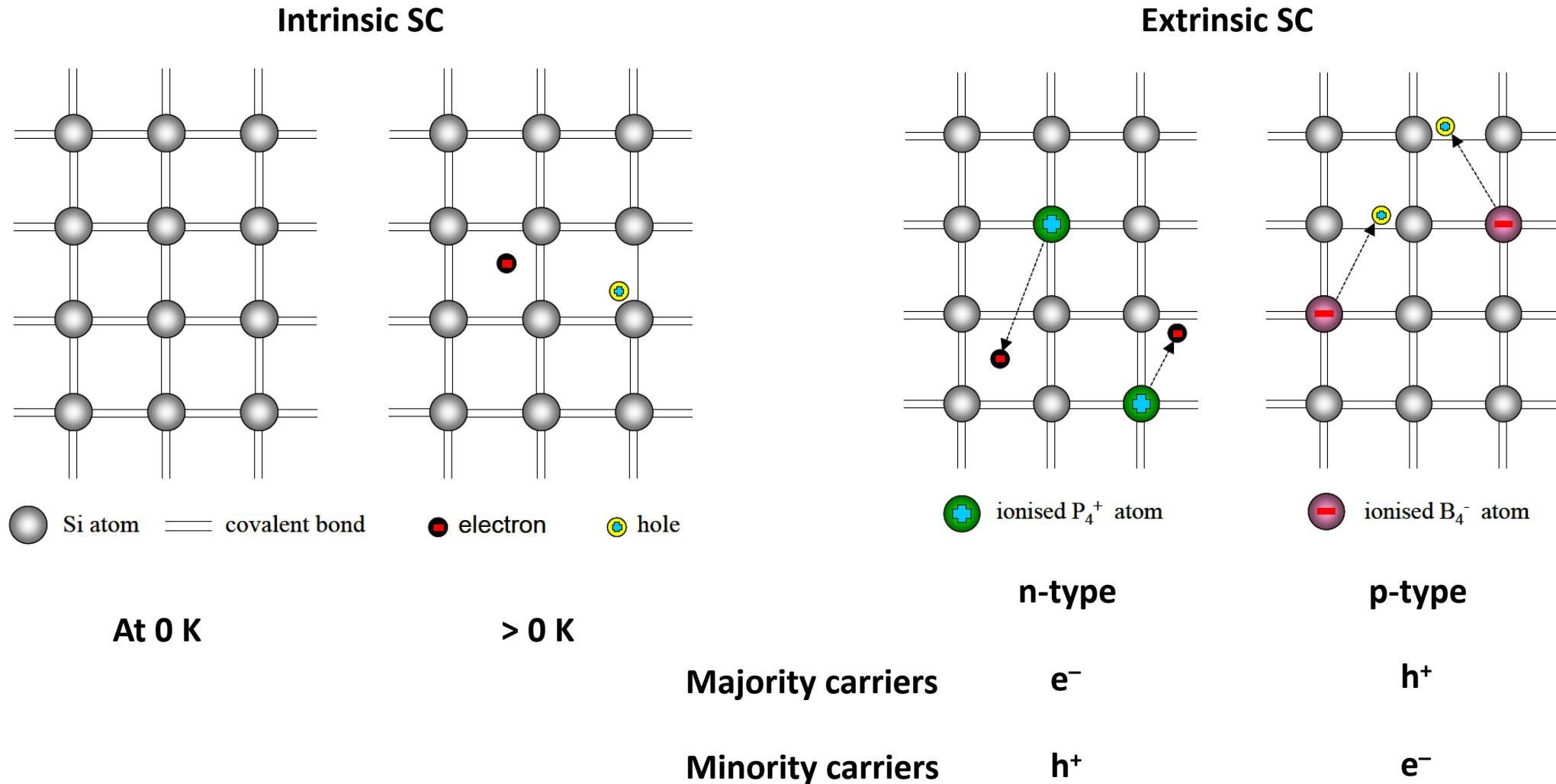
Donor (D, N_D)

Acceptor (A, N_A)

Low doping Moderate doping Heavy doping

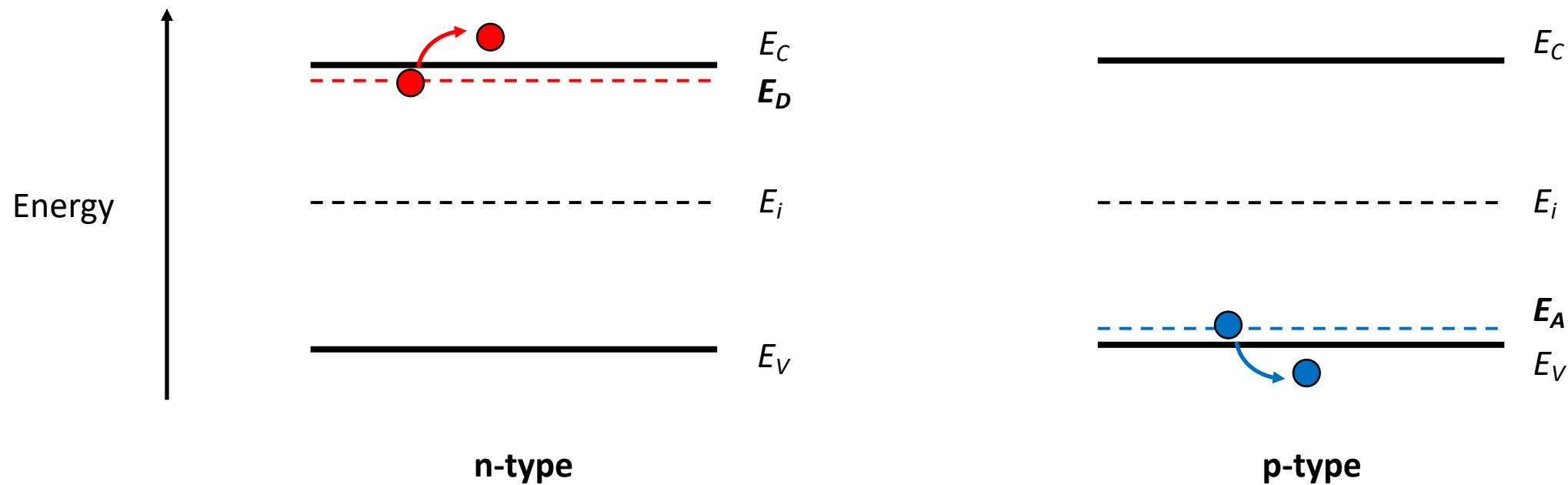


The doping process can greatly alter the electrical characteristics of the semiconductor. This doped semiconductor is called an extrinsic material.

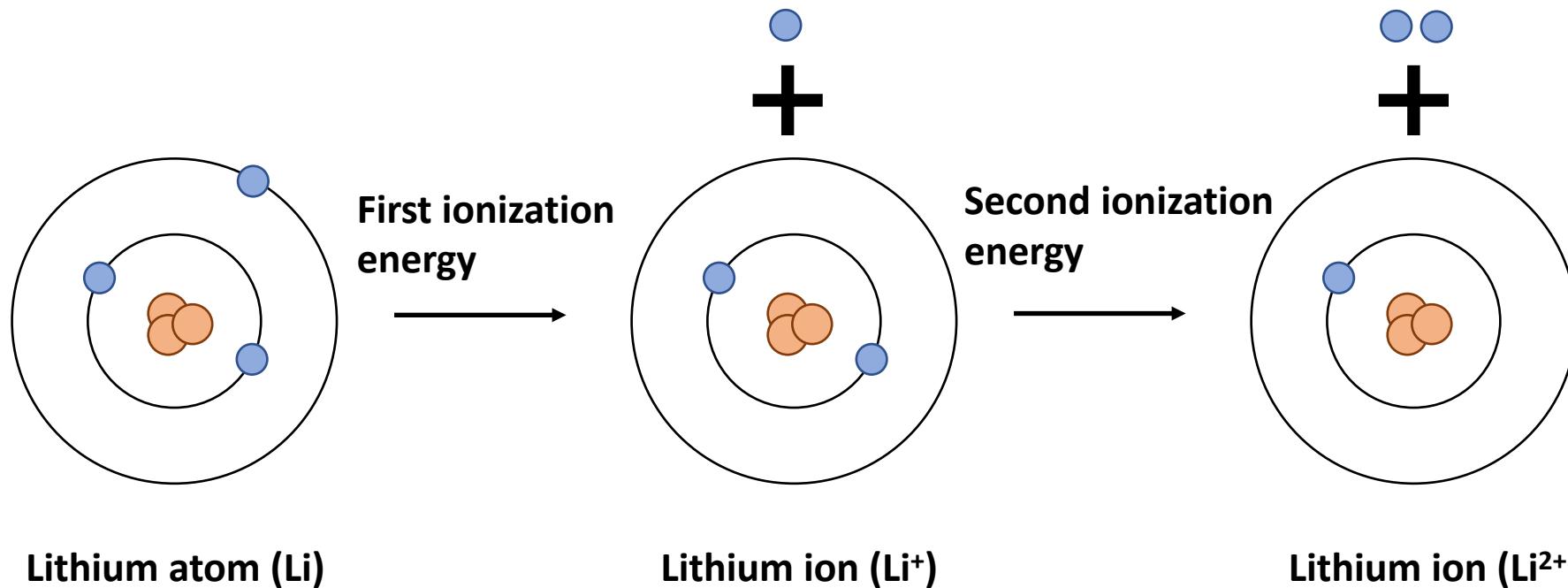
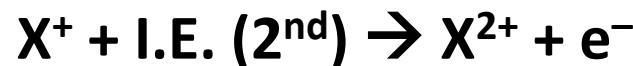
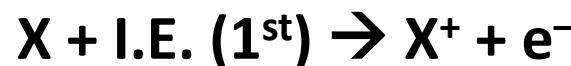


The concentration of electrons and holes is influenced by the amount of the impurity atoms that substitute semiconductor atoms in the lattice.

Donor (Acceptor) atoms introduce donor energy levels, E_D (Acceptor Energy levels, E_A) near the C.B. (V.B.) so that the electrons (the holes) exited to C.B. (V.B.) at R.T: **Ionization**.



Ionization energy (I.E.) (Ionization potential) is the amount of energy required to remove the most loosely attached **1 mole electron** from an **isolated gaseous 1 mole neutral atom**, which forms an ion (eV or kJ/mol).



The energy required to ionize a donor atom (i.e., to free the extra electron and leave a positive ion behind) can be estimated by modifying the theory of the ionization energy of a hydrogen atom,

$$E_H = \frac{m_0 q^4}{8 \varepsilon_0^2 h^2} = 13.6 \text{ eV}$$

Small modification includes:

$$E_{ion} = \frac{m^* q^4}{8(\varepsilon_0 \varepsilon_r)^2 h^2}$$

The result is about 24.6 meV and 37.1 meV for donor energy and acceptor energy. Because of such small ionization energies, they are usually fully ionized at room temperature.

	Donors			Acceptors		
Dopant	Sb	P	As	B	Al	In
Ionization Energy (meV)	39	44	54	45	57	160
	$E_C - E_D$			$E_A - E_V$		

Under equilibrium conditions, the local charge is zero in the uniformly doped semiconductor
 = the charge neutrality condition

$$p + N_D^+ - n - N_A^- = 0$$

By definition

$$N_D^+ = N_D - n_D$$

$$N_A^- = N_A - p_A$$

$$p + (N_D - n_D) = n + (N_A - p_A)$$

n : thermal-equilibrium concentration of electrons

p : thermal-equilibrium concentration of holes

n_D : concentration of electrons in the donor energy state

p_A : concentration of holes in the acceptor energy state

N_D : concentration of donor atoms

N_A : concentration of acceptor atoms

N_D^+ : concentration of positively charged donors (ionized donors)

N_A^- : concentration of negatively charged acceptors (ionized acceptors)

At room temperature we assume complete ionization. $n_D = p_A = 0$

$$p + N_D = n + N_A$$

Mass action law: $np = n_i^2$

$$n = 1/2[(N_D - N_A) + ((N_D - N_A)^2 + 4n_i^2)^{1/2}]$$

$$N_D > N_A$$

For n-type

$$p = 1/2[(N_A - N_D) + ((N_A - N_D)^2 + 4n_i^2)^{1/2}]$$

$$N_A > N_D$$

For p-type

EPFL Determine the thermal equilibrium e^- and h^+ concentrations

Example 1) Consider a silicon semiconductor at $T = 300 \text{ } ^\circ\text{K}$ in which $N_D = 10^{16} \text{ cm}^{-3}$ and $N_A = 3 \times 10^{15} \text{ cm}^{-3}$. Assume that $n_i = 1 \times 10^{10} \text{ cm}^{-3}$. Calculate the carrier concentrations (electrons and holes)!

Solution 1)

The majority carrier electron concentration is

$$n = 1/2 \left[(N_D - N_A) + ((N_D - N_A)^2 + 4n_i^2)^{1/2} \right] = 7 \times 10^{15} \text{ cm}^{-3}$$

The minority carrier hole concentration is

$$p = n_i^2/n = (1 \times 10^{10})^2/(7 \times 10^{15}) = 1.43 \times 10^4 \text{ cm}^{-3}$$

$$\text{if } N_D - N_A \gg n_i \quad n = N_D - N_A \quad p = n_i^2/(N_D - N_A)$$

$$\text{if } N_A - N_D \gg n_i \quad p = N_A - N_D \quad n = n_i^2/(N_A - N_D)$$

EPFL Determine the thermal equilibrium e^- and h^+ concentrations

Example 2) Consider an n-type silicon semiconductor at $T = 300 \text{ } ^\circ\text{K}$ in which $N_D = 10^{16} \text{ cm}^{-3}$ and $N_A = 0$. The intrinsic carrier concentration is assumed to be $n_i = 1 \times 10^{10} \text{ cm}^{-3}$. Calculate the carrier concentrations!

Solution 2)

The majority carrier electron concentration is

$$n = 1/2[(N_D - N_A) + ((N_D - N_A)^2 + 4n_i^2)^{1/2}] = 10^{16} \text{ cm}^{-3}$$

The minority carrier hole concentration is

$$p = n_i^2/n = (1 \times 10^{10})^2/10^{16} = 1 \times 10^4 \text{ cm}^{-3}$$

$$\text{if } N_D \gg N_A$$

$$n = N_D$$

$$p = n_i^2/N_D$$

$$\text{if } N_A \gg N_D$$

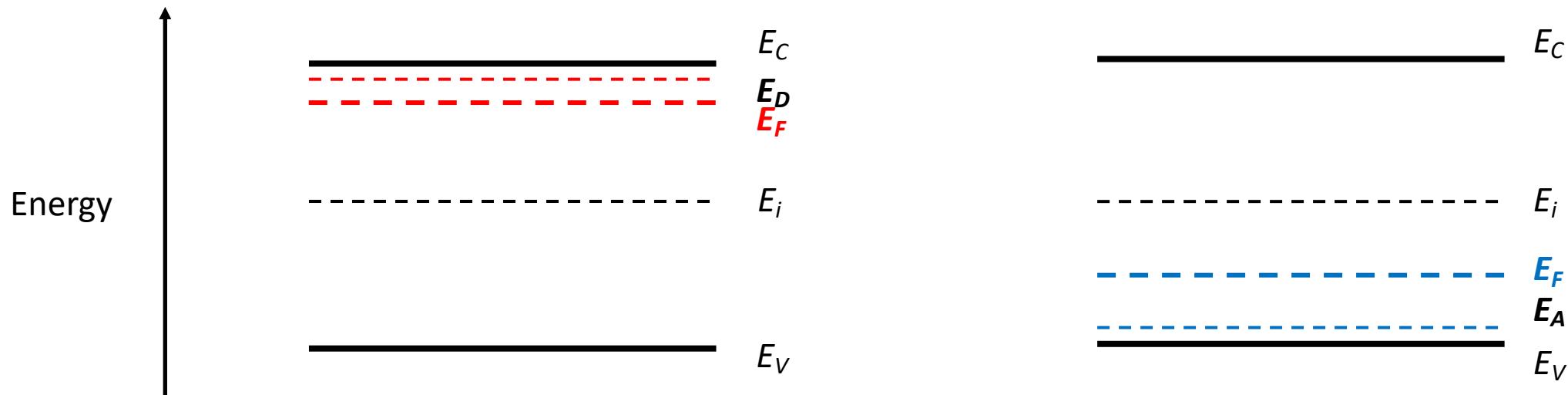
$$p = N_A$$

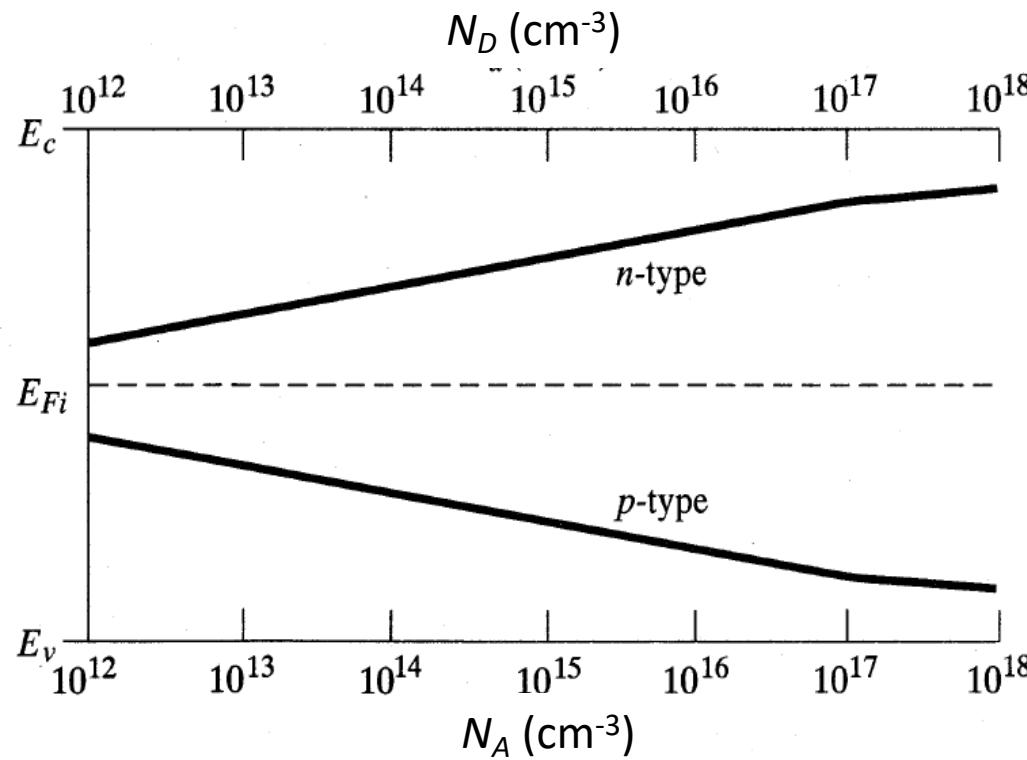
$$n = n_i^2/N_A$$

Example) Where is E_F located in the energy band of silicon, at 300 °K with $n = 10^{17} \text{ cm}^{-3}$? And for $p = 10^{14} \text{ cm}^{-3}$?

Solution) $n = N_C \exp \left[\frac{(E_F - E_C)}{k_B T} \right] \rightarrow E_C - E_F = k_B T \ln \left(\frac{N_C}{n} \right) = 0.146 \text{ eV}$ with $N_C = 2.81 \times 10^{19} \text{ cm}^{-3}$

Solution) $p = N_V \exp \left[\frac{(E_V - E_F)}{k_B T} \right] \rightarrow E_F - E_V = k_B T \ln \left(\frac{N_V}{p} \right) = 0.314 \text{ eV}$ with $N_V = 1.83 \times 10^{19} \text{ cm}^{-3}$





Position of Fermi level as a function of donor and acceptor concentration.

E_F for n-type

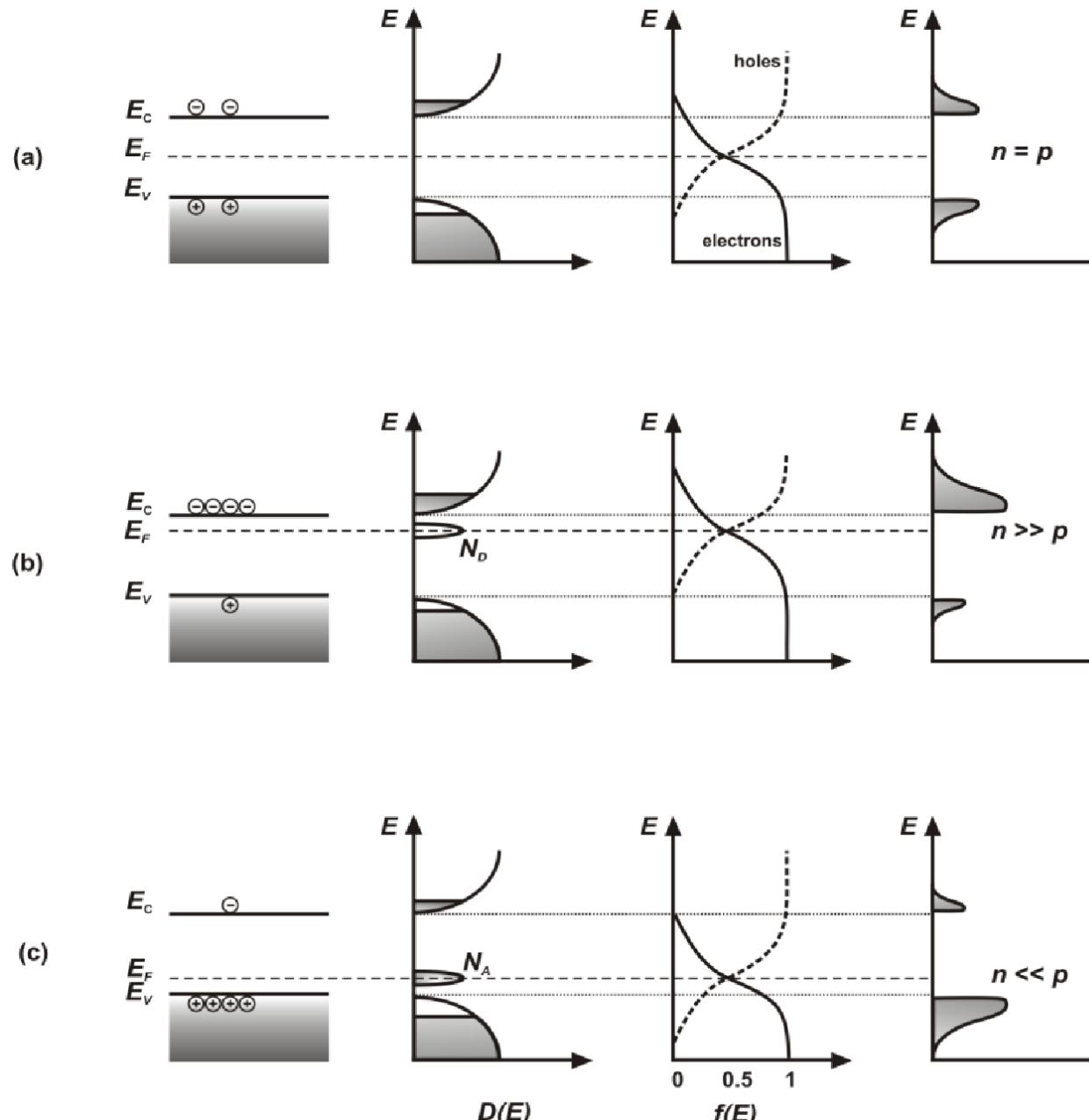
$$E_C - E_F = k_B T \ln \left(\frac{N_C}{n} \right) = k_B T \ln \left(\frac{N_C}{N_D} \right)$$

$$E_F - E_{Fi} = k_B T \ln \left(\frac{n}{n_i} \right)$$

E_F for p-type

$$E_F - E_V = k_B T \ln \left(\frac{N_V}{p} \right) = k_B T \ln \left(\frac{N_V}{N_A} \right)$$

$$E_{Fi} - E_F = k_B T \ln \left(\frac{p}{n_i} \right)$$



At room temperature we assumed complete ionization. $n_D = p_A = 0$

If this is not true???

The derivation of the Fermi-Dirac probability function was derived considering the Pauli exclusion principle. This principle also applies to the donor and acceptor states.

$$f(E) = \frac{1}{1 + \exp(\frac{E - E_F}{k_B T})} \quad \rightarrow \quad \frac{n_D}{N_D} = \frac{1}{1 + \frac{1}{g} \exp(\frac{E_D - E_F}{k_B T})}$$

$g = 2$ for electron
 $g = 4$ for holes (Si, GaAs due to two-fold degeneracy of the V.B. e.g. heavy hole and light hole)

We assumed $E_D - E_F \gg k_B T$, $n_D \approx \frac{N_D}{\frac{1}{2} \exp(\frac{E_D - E_F}{k_B T})} = 2N_D \exp(\frac{E_F - E_D}{k_B T})$

$$\frac{\text{electrons in the donor state}}{\text{total electrons}} = \frac{n_D}{n_D + n} = \frac{2N_D \exp(\frac{E_F - E_D}{k_B T})}{2N_D \exp(\frac{E_F - E_D}{k_B T}) + N_C \exp(\frac{E_F - E_C}{k_B T})} = \frac{1}{1 + \frac{N_C}{2N_D} \exp(\frac{E_D - E_C}{k_B T})}$$

Let's determine the fraction of electrons are still in the donor state at $T = 300 \text{ } ^\circ\text{K}$ in the case of P donor atoms in Si ($N_D = 10^{17} \text{ cm}^{-3}$).

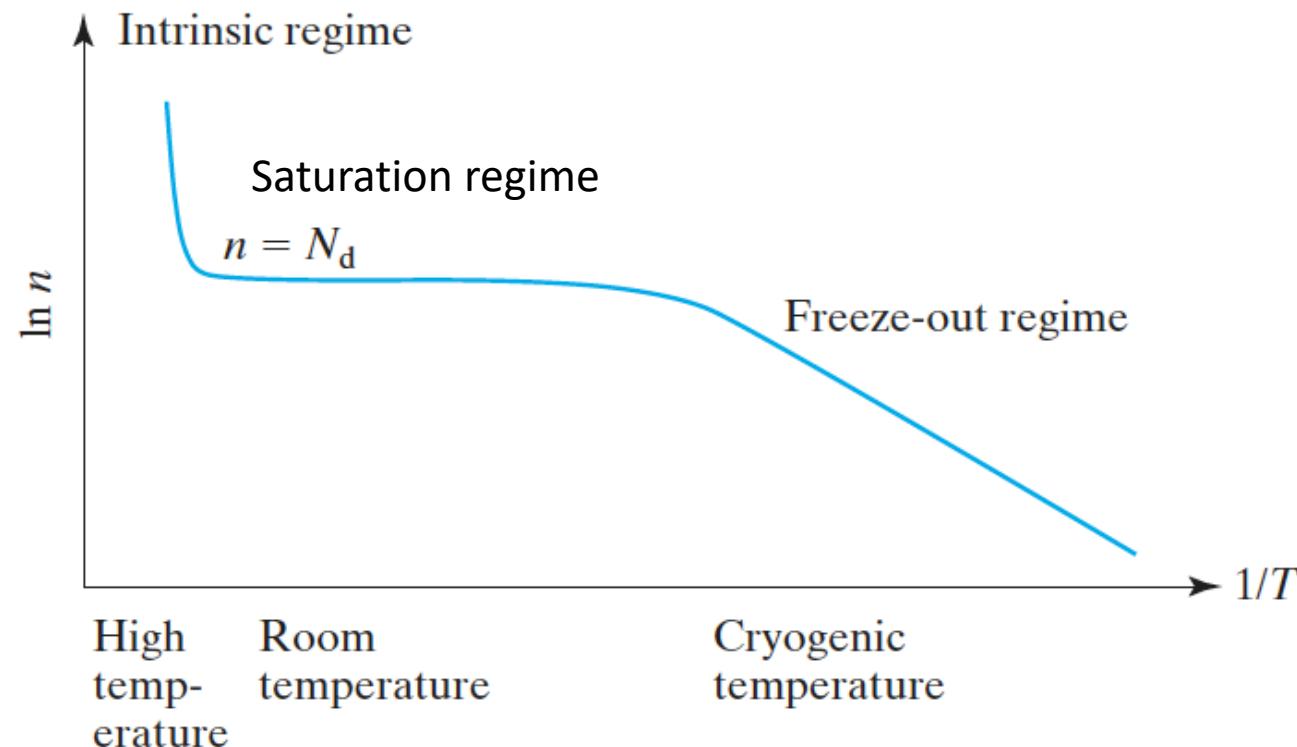
$$\frac{n_D}{n_D + n} = \frac{1}{1 + \frac{2.82 \times 10^{19}}{2(10^{17})} \exp\left(\frac{44 \text{ meV}}{25.9 \text{ meV}}\right)} = 0.0013 = 0.13\%$$

This example shows that at RT only few electrons are in the donor state compared with the C.B. Only 0.13% of the donor states contain electrons.

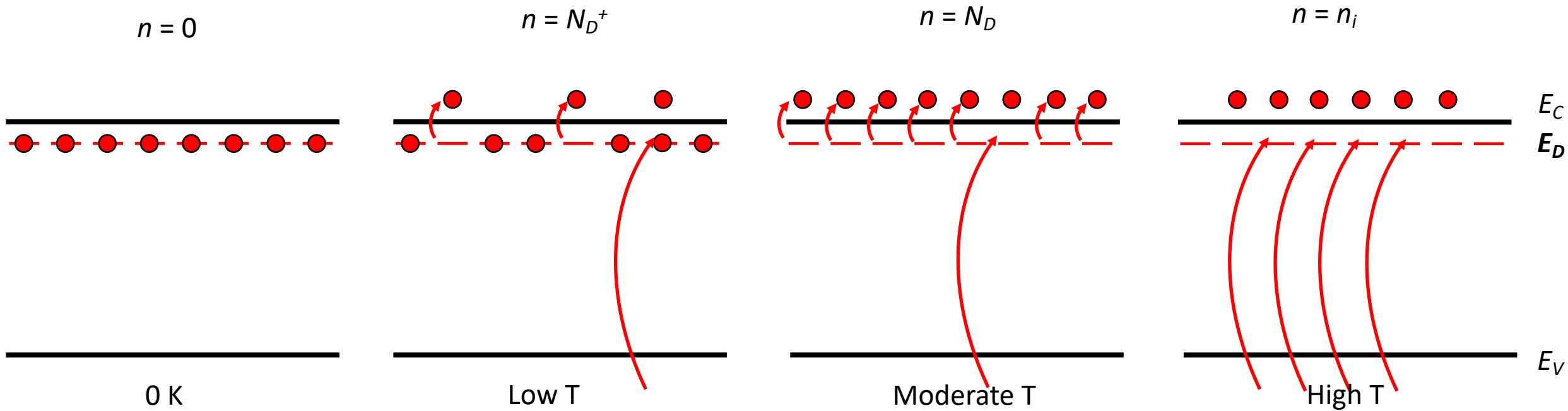
The same is valid for the acceptor states.

What if $T = 0 \text{ } ^\circ\text{K}$ or much higher than RT?

- In Freeze-out regime, donor atoms are only partially ionized.
- In the saturation regime, donors are fully ionized and carrier concentration is a constant.
- At high T, it behaves like an intrinsic semiconductor.

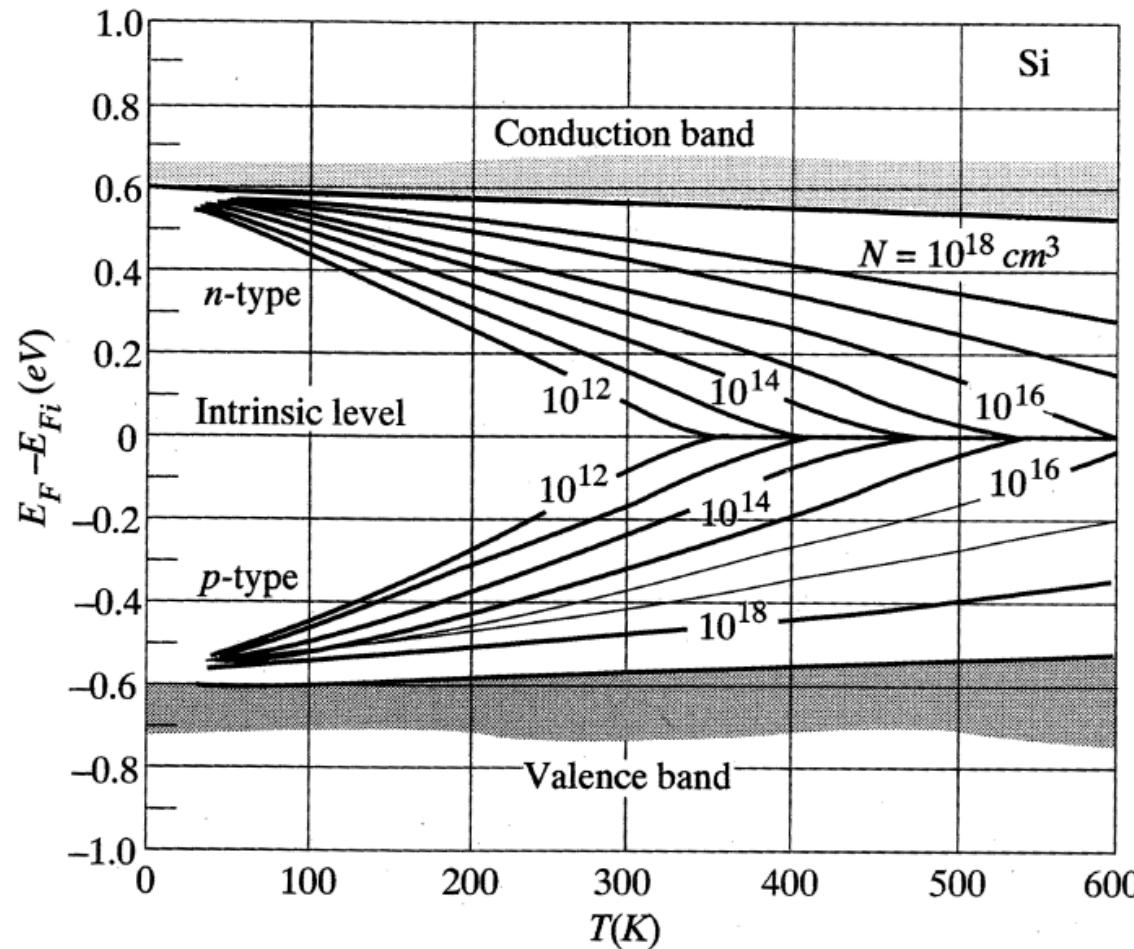


EPFL Temperature Dependence of the Carrier Concentration



Mini calculator for intrinsic carrier concentration: <https://www.pveducation.org/pvcdrom/pn-junctions/intrinsic-carrier-concentration>

Position of Fermi level as a function of T for various doping concentrations



- n_i strongly depends from T
- E_F is a function of T.
- As T increases, n_i increases.
- As T increases, $E_F \rightarrow E_i$
- At high T the semiconductor loses the extrinsic characteristics and behaves as intrinsic.
- At low T freeze-out occurs, Boltzmann approximation is not longer valid.

The equations we derived the Fermi level position no longer apply.

$E_F \rightarrow E_D$ for n-type and $E_F \rightarrow E_A$ for p-type

Current Flow: Motion of electron and hole

Generation: Local creation of electron-hole pairs

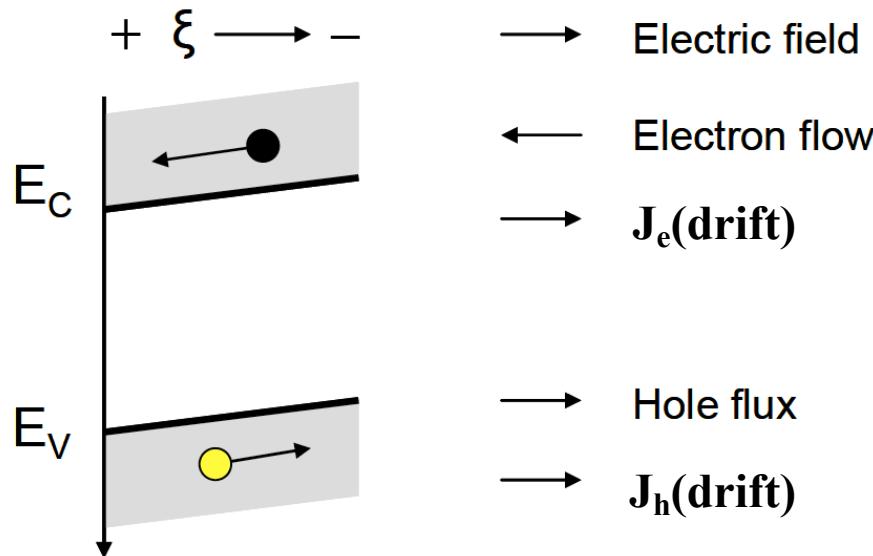
Recombination: Local annihilation of electron-hole pairs

The net flow of the electrons and holes in a semiconductor will generate currents. The process by which these charged particles move is called transport.

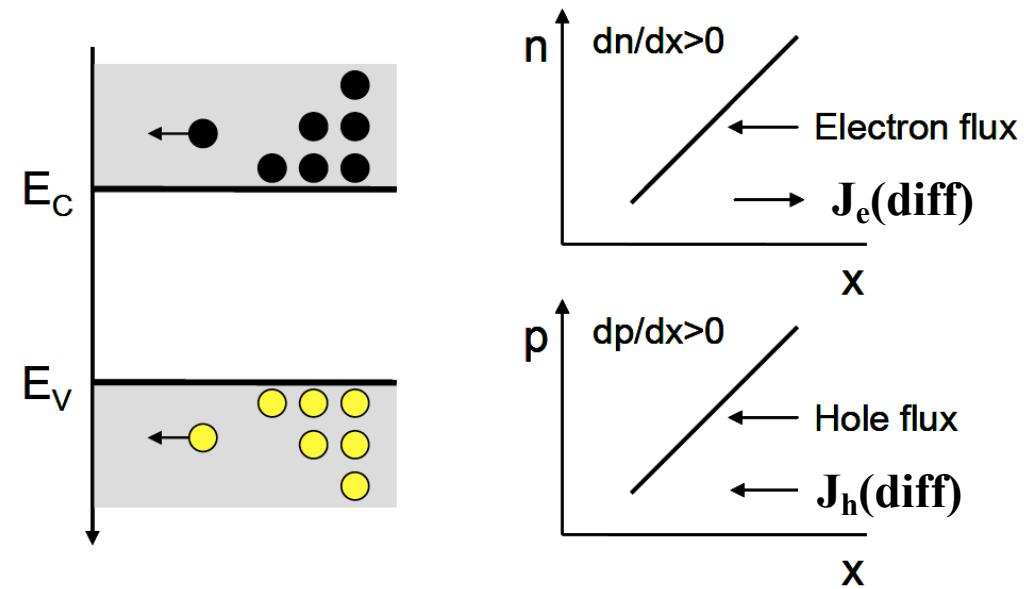
The two basic transport mechanisms in a semiconductor:

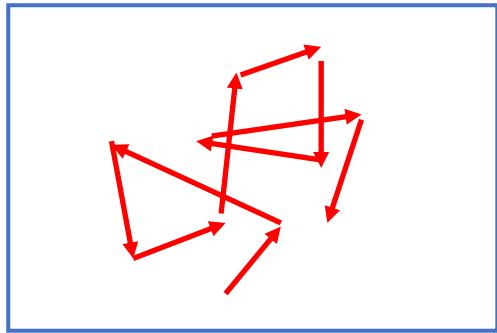
- **Drift:** the movement of charge due to electric fields
- **Diffusion:** the flow of charge to cancel any spatial inhomogeneity in carrier density

Drift

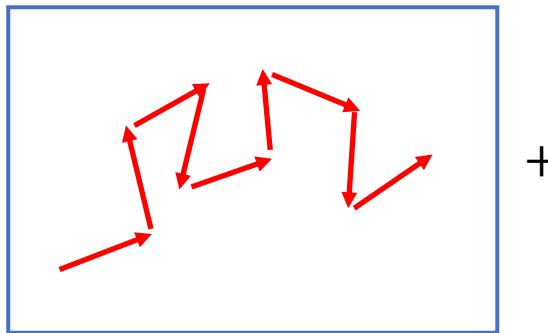


Diffusion

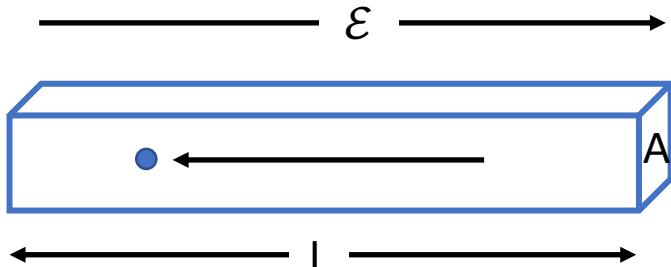




- Electrons and holes in solid at thermal equilibrium move in random directions.
- Electrons and holes scatter randomly by lattice, impurity (ionized or neutral), and defects.
- No net velocity



- In the presence of an electric field, electrons (holes) drift: Electrons in the opposite direction of the E-field and holes in the direction of the E-field.
- Motion is non-directional on a local scale but has a net direction on a macroscopic scale, which gives rise to a current.
- Average net motion is described by the average drift velocity, v_d .



Assumption: All the carriers in the semiconductor move with the same average velocity.

$$I = \frac{Q}{t_r} = \frac{Q}{L/v_{drift}} \quad \text{where } t_r \text{ is the transit time of a particle, traveling with average velocity, } v_d, \text{ over the distance } L$$

$$J = \frac{Q}{AL/v_d} = \rho v_{drift} \quad J \text{ is drift current density and } \rho \text{ is positive volume charge density} = p \times q \text{ or } n \times q.$$

$$J_{e(drift)} = -env_e \quad \text{and} \quad J_{h(drift)} = epv_h$$

$$v_e = -\mu_e \mathcal{E}$$

$$v_h = \mu_h \mathcal{E}$$

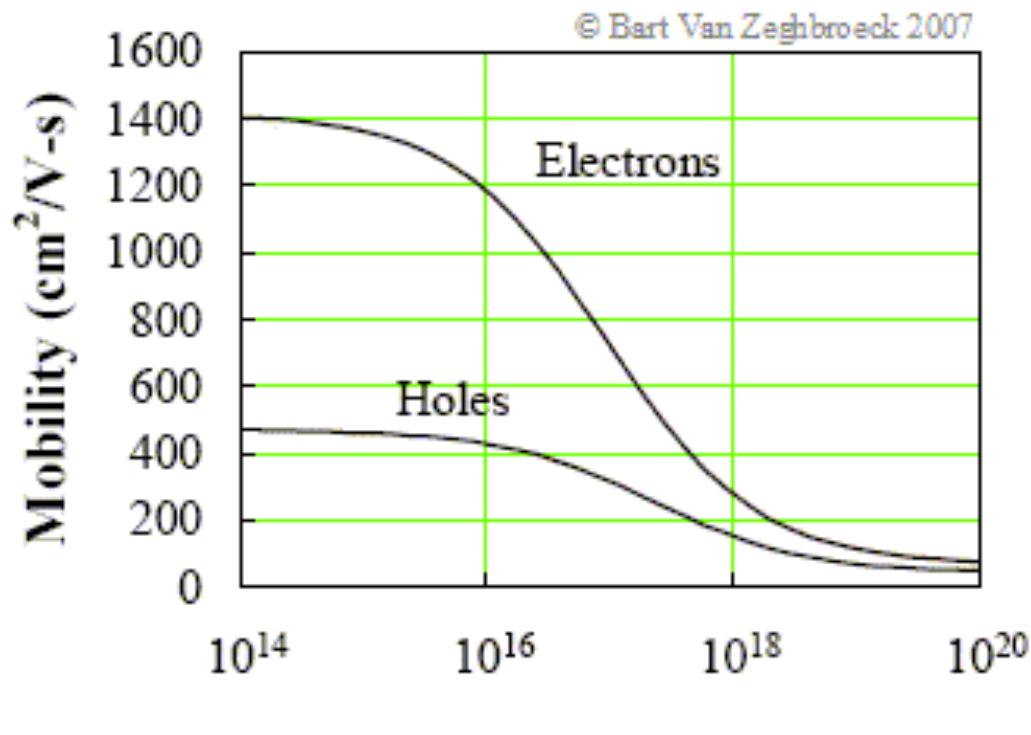
For low electric field, the average drift velocities are directly proportional to the E-field.

$$J_{e(drift)} = en\mu_e \mathcal{E}$$

$$J_{total(drift)} = en\mu_e \mathcal{E} + ep\mu_h \mathcal{E} = (en\mu_e + ep\mu_h) \mathcal{E} = \sigma \mathcal{E}$$

$$J_{h(drift)} = ep\mu_h \mathcal{E}$$

Mobility depends on doping level and whether carrier is majority or minority-type.



Phonon scattering

impurity scattering

$$\mu = \mu_{\min} + \frac{\mu_{\max} - \mu_{\min}}{1 + \left(\frac{N}{N_r}\right)^{\alpha}}$$

	As	P	B
μ_{\min} ($\text{cm}^2/\text{V}\cdot\text{sec}$)	52.2	68.5	44.9
μ_{\max} ($\text{cm}^2/\text{V}\cdot\text{sec}$)	1417	1414	470.5
N_r (cm^{-3})	9.68×10^{16}	9.20×10^{16}	2.23×10^{17}
α	0.68	0.711	0.719